# PROGRAMMABLE CONTROLLER PROSEC **T3**

# USER'S MANUAL - HARDWARE -

**Contents** 

Toshiba Corporation

#### Important Information

Misuse of this equipment can result in property damage or human injury. Because controlled system applications vary widely, you should satisfy yourself as to the acceptability of this equipment for your intended purpose. In no event will Toshiba Corporation be responsible or liable for either indirect or consequential damage or injury that may result from the use of this equipment.

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This manual is prepared for users of Toshiba's Programmable Controller PROSEC T3. Read this manual thoroughly before using the T3. Also, keep this manual and related manuals so that you can read them anytime while the T3 is in operation.

#### **General Information**

- 1. The T3 has been designed and manufactured for use in an industrial environment. However, the T3 is not intended to be used for systems which may endanger human life. Consult Toshiba if you intend to use the T3 for a special application, such as transportation machines, medical apparatus, aviation and space systems, nuclear controls, submarine systems, etc.
- 2. The T3 has been manufactured under strict quality control. However, to keep safety of overall automated system, fail-safe systems should be considered outside the T3.
- 3. In installation, wiring, operation and maintenance of the T3, it is assumed that the users have general knowledge of industrial electric control systems. If this product is handled or operated improperly, electrical shock, fire or damage to this product could result.
- 4. This manual has been written for users who are familiar with Programmable Controllers and industrial control equipment. Contact Toshiba if you have any questions about this manual.
- 5. Sample programs and circuits described in this manual are provided for explaining the operations and applications of the T3. You should test completely if you use them as a part of your application system.

#### **Hazard Classifications**

In the following pages, the following two hazard classifications are used to explain the safety precautions.

WARNING Indicates a potentially hazardous situation which, if not avoided, could result in death or serious injury.

Indicates a potentially hazardous situation which, if not avoided, may result in minor or moderate injury. It may also be used to alert against unsafe practices.

Even a precaution is classified as CAUTION, it may cause serious results depending on the situation. Observe all the safety precautions described on this manual.

#### **Safety Precautions**

#### Installation:

### **⚠** CAUTION

- 1. Excess temperature, humidity, vibration, shocks, or dusty and corrosive gas environment can cause electrical shock, fire or malfunction. Install and use the T3 in the environment described in this manual.
- 2. Improper installation directions or insufficient installation can cause fire or the units to drop. Install the T3 in accordance with the instructions described in this manual.
- Turn off power before installing or removing any units, modules or terminal blocks.
   Failure to do so can cause electrical shock or damage to the T3 and related equipment.
- 4. Entering wire scraps or other foreign debris into to the T3 and related equipment can cause fire or malfunction. Pay attention to prevent entering them into the T3 and related equipment during installation and wiring.

#### Wiring:

### **A** CAUTION

- 1. Turn off power before wiring to minimize the risk of electrical shock.
- Exposed conductive parts of wire can cause electrical shock. Use crimp-style
  terminals with insulating sheath or insulating tape to cover the conductive parts. Also
  close the terminal covers securely on the terminal blocks when wiring has been
  completed.
- 3. Operation without grounding may cause electrical shock or malfunction. Connect the ground terminal on the T3 to the system ground.
- 4. Applying excess power voltage to the T3 can cause explosion or fire. Apply power of the specified ratings described in this manual.
- 5. Improper wiring can cause fire, electrical shock or malfunction. Observe local regulations on wiring and grounding.

#### II PROSEC T3

#### Operation:

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 Configure emergency stop and safety interlocking circuits outside the T3. Otherwise, malfunction of the T3 can cause injury or serious accidents.

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- 2. Operate the T3 and the related modules with closing the terminal covers. Keep hands away from terminals while power on, to avoid the risk of electrical shock.
- 3. When you attempt to perform force outputs, RUN/HALT controls, etc. during operation, carefully check for safety.
- 4. Turn on power to the T3 before turning on power to the loads. Failure to do so may cause unexpected behavior of the loads.
- 5. Set operation mode switches of the T3 and I/O modules. Improper switch settings may cause malfunction of the T3 and related equipment.
- 6. Do not use any modules of the T3 for the purpose other than specified. This can cause electrical shock or injury.
- 7. Configure the external circuit so that the external power required for output modules and power to the loads are switched on/off simultaneously. Also, turn off power to the loads before turning off power to the T3.
- 8. Install fuses appropriate to the load current in the external circuits for the relay output modules. Failure to do so can cause fire in case of load over-current.
- 9. Check for proper connections on wires, connectors and modules. Insufficient contact can cause malfunction or damage to the T3 and related equipment.
- 10. Turn off power immediately if the T3 is emitting smoke or odor. Operation under such condition can cause fire or electrical shock.
  - Also unauthorized repairing will cause fire or serious accidents. Do not attempt to repair. Contact Toshiba for repairing.

#### Maintenance:

### **A** CAUTION

- 1. Do not charge, disassemble, dispose in a fire nor short-circuit the batteries. It can cause explosion or fire. Observe local regulations for disposal of them.
- 2. Turn off power before removing or replacing units, terminal blocks or wires. Failure to do so can cause electrical shock or damage to the T3 and related equipment.
- 3. Replace a blown fuse with a specified one. Failure to do so can cause fire or damage to the T3.
- 4. Perform daily checks, periodical checks and cleaning to maintain the system in normal condition and to prevent unnecessary troubles.
- 5. Check by referring "Troubleshooting" section of this manual, when operating improperly. Contact Toshiba for repairing if the T3 or related equipment is failed. Toshiba will not guarantee proper operation nor safety for unauthorized repairing.
- 6. The contact reliability of the relays used in the relay output module will reduce if the switching exceeds the specified life. Replace the module if exceeded.
- 7. Replace the battery every 2 years to maintain the T3's program and data normally.
- 8. Do not modify the T3 and related equipment in hardware nor software. This can cause fire, electrical shock or injury.
- 9. Pay special attention for safety if you attempt to measure circuit voltage at the T3's terminal.
- 10. Turn off power before replacing modules. Failure to do so can cause electrical shock or damage to the T3 and related equipment.
  If you attempt to replace an I/O module while power on (by using on-line I/O replacement function), carefully check for safety.

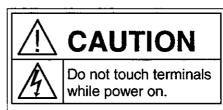
### **Safety Label**

The safety label as shown on the right is attached to the power terminal of the T3.

Remove the mount paper before wiring.

Peel off the label from the mount paper and stick it near the power terminals where it can be readily seen.

Contact Toshiba if the label is damaged.



Hazardous voltage can shock, burn or cause death. Do not touch terminals while power on. Read related manual thoroughly for safety. Stick this seal on unit or near unit.

Take off this sheet before wiring.

#### **FOR SAFETY**

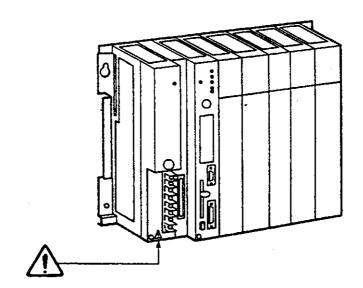
To use the T3 safely, read this section carefully before use.

- 1. Only use the T3 after first carefully reading this Manual and related guides.
- 2. Do not use in any of the following environments, as they will cause malfunctions:-
  - (1) Where the ambient temperature of the T3 (the temperature inside the panel) is 0°C or below or 55°C or above
  - (2) Where the ambient humidity of the T3 (the humidity inside the panel) is 20% or less or 90% or more
  - (3) Where condensation may form due to severe changes of temperature
  - (4) Where there are vibration or violent shocks
  - (5) Where there are corrosive gases or flammable gases
  - (6) Where there is dust, salinity or iron content
  - (7) Where there is direct sunlight
- 3. Pay attention to the following at the T3 installation site:-
  - (1) For safety in maintenance and operation, keep a distance of at least 200mm from high-voltage equipment (high-voltage lines) and power equipment (power lines), or separate by a shield such as a steel plate.
  - (2) Keep the expansion cables separate from other power sources when wiring. In particular, separate by at least 200mm from high-power lines.
  - (3) Provide an air space of at least 70mm around the units for ventilation.
  - (4) Install the units vertically.
- 4. The T3 power supply module is a dedicated module for the T3. Do not use it on its own for other purposes.
- 5. For the wiring to the module, use crimp-style terminals fitted with reverse power sheaths. When it is not possible to use crimp-style terminals fitted with sheaths, cover with insulating tape and ensure that the conducting parts are not exposed.

This is the warning mark for dangerous locations. It is attached to the equipment in positions where there is a risk of electric shock and in positions where there is a risk of damage to the equipment through wrong wiring.

Take the following precautions where there is a A mark:-

- (1) Hazardous voltage can shock or cause severe injury if you touch the power input terminals while power on. Do not touch the power input terminals.
- (2) For safety, always switch off power when wiring and during maintenance and inspections.
- (3) Wire the power input terminals correctly and do not apply voltages in excess of the specified voltage limits, since this will cause the equipment damege.



The purpose of this

manual

This manual explains the hardware of the programmable controller PROSEC T3. The explanation covers the configuration,

specification, installation, wiring, maintenance and service.

Scope of this manual

This manual covers the following basic parts of the T3 system.

T3 main body: CPU module

Power supply module

Rack

Expansion interface module

Basic DI/O: 32 points DC input module (12-24 Vdc)

64 points DC input module (24 Vdc)

32 points AC input module (100-120 Vac, 200-240 Vac)

16 points DC output module (12-24 Vdc)

32 points DC output module (12-24 Vdc)

64 points DC output module (5-24 Vdc)

16 points AC output module (100-240 Vac)

32 points AC output module (100-240 Vac) 32 points relay output module (240 Vac/24 Vdc)

16 points isolated relay output module (240 Vac/24 Vdc)

### Before reading this manual

#### Related manuals

The following related manuals are available for the T3.

#### T3 User's Manual - Hardware

This manual covers the T3's main body and basic I/O - their specifications, handling, maintenance and services.

#### T3 User's Manual - Functions

This document explains the functions of the T3 and how to use them. The necessary information to create user program is covered in this volume.

#### **T-series Instruction Set**

This manual provides the detailed specifications of instructions for Toshiba's T-series Programmable Controllers.

#### **T-PDS Basic Operation Manual**

This manual explains how to install the T-series program development system (T-PDS) into your personal computer and provides basic programming operations.

#### **T-PDS Command Reference Manual**

This manual explains each command of the T-series program development system (T-PDS) in detail.

#### **T-series Computer Link Function**

This manual explains the specification and handling method of the T-series Programmable Controller's Computer Link function.

#### Note and caution symbols

Users of this manual should pay special attention to information preceded by the following symbols.



Calls the reader's attention to information considered important for full understandings of programming procedures and/or operation of the equipment.



CAUTION Calls the reader's attention to conditions or practices that could damage the equipment or render it temporarily inoperative.

Te	rm	in	ol	oq	٧

AWG

American Wire Gage

ASCII

American Standard Code for Information Interchange

CPU

Central Processing Unit EEPROM Electrically Erasable Programmable Read Only Memory

IF Interface

I/O

Input/Output

LED

Light-Emitting Diode

ms

millisecond

NEMA

National Electrical Manufacturers' Association

PLC

Programmable Controller

PS

Power supply

RAM

Random Access Memory

ROM

Read Only Memory

μS

microsecond

Vac

ac voltage

Vdc

dc voltage

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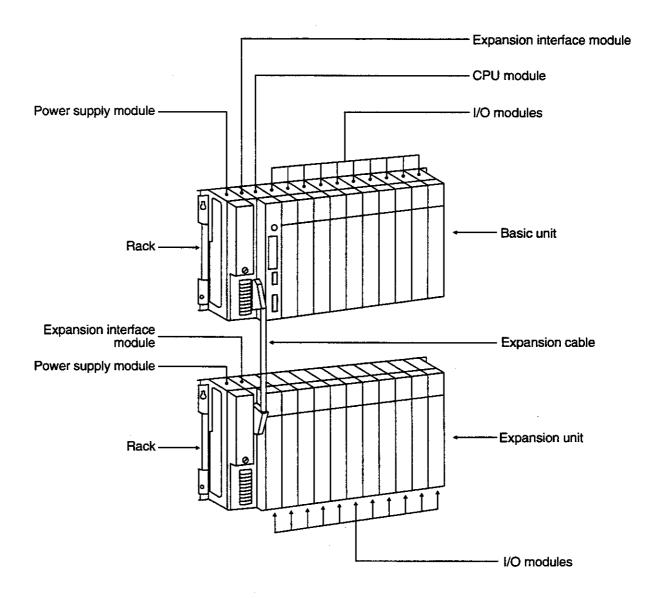
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1.1 T3 hardware configuration

The T3 consists of the rack (s), the power supply modules (s), the CPU module, the expansion interface module (s), the expansion cables (s) and I/O modules (s).



The modules which configure the T3 system are listed below. (except I/O modules)

### Power supply module

1		Туре	Description
	1	PS361	Power supply voltage: 100-120 Vac/200-240 Vac, common for basic and expansion units
	2	PS332	Power supply voltage: 24 Vdc, common for basic and expansion units

#### **CPU** module

	Туре	Description
1	PU315	RAM
2	1 211375	RAM+EEPROM

#### Rack

	Туре	Description			
1	BU31A	For basic	10 slots for I/O modules		
2	BU315	unit	5 slots for I/O modules		
3	BU35B	For expansion	11 slots for I/O modules		
4	BU356	unit	6 slots for I/O modules		

#### Expansion interface module

	Type		Description
1	IF311	For basic unit	Standard type, 2m maximum between the units,
2	IF351	For expansion unit	total 6 m maximum
3	IF312	For basic unit	
4	IF352	For middle expansion unit	Long-distance type, total 40 m maximum
5	IF353	For end expansion unit	

### **Expansion cable**

	Type		Description
1	CS3R5	0.5m	
2	CS301	1m	Standard type, both-end connector (50-pin)
3	CS302	2m	(30 pm)
4	CL3R5	0.5m	
5	CL301	1m	
6	CL305	5m	Long-distance type,
7	CL310	10m	both-end connector (68-pin)
8	CL320	20m	
9	CL340	40m	

### 1.2 Unit configuration

(1) Minimum configuration of the T3

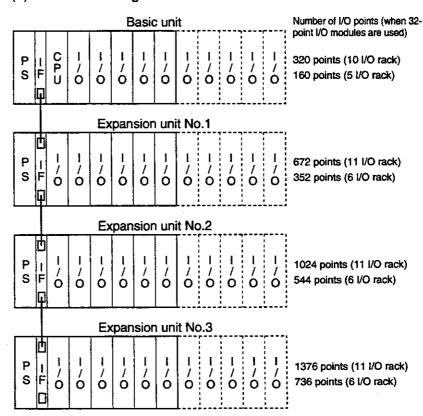
P S	CPU	-/0	1/0	1/0	1/0	I / O	1/0	1/0	1/0	ι / Ο	     	
--------	-----	-----	-----	-----	-----	-------	-----	-----	-----	----------	----------------	--

Basic unit (10 I/O rack) 320 points (32-point I/O)

e ທ	CPD	0	-/0	-/0	- <i>/</i> 0	1/0	
-----	-----	---	-----	-----	--------------	-----	--

Basic unit (5 I/O rack) 160 points (32-point I/O)

- The minimum configuration of the T3 is one basic unit. In this case, no expansion interface module is needed.
- (2) Maximum configuration of the T3



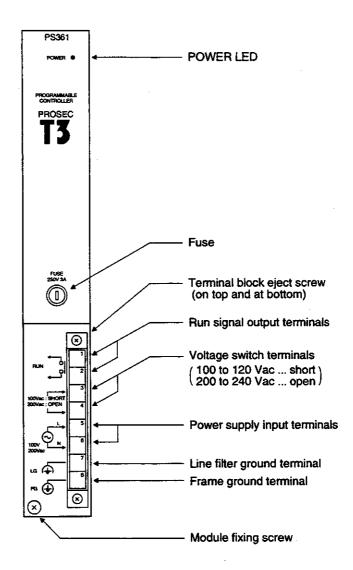
- Up to three expansion units can be connected to the basic unit.
- There is no limitation in combining different size of racks.
- The expansion interface module is needed for each unit. (indicated as "IF" in the figure)
   The expansion interface module is dedicated for basic or expansion units

- If the standard type expansion is used, all expansion interface modules must be the standard type. In this case, the maximum length of the expansion cable is 2m between units, 6m total.
- If the long-distance type expansion is used, all expansion interface modules must be the long-distance type. In this case, the maximum length of the expansion cable is total 40m.
- If the standard type expansion is used, the necessity of the power supply modules on the expansion units is determined depending on the internal current consumption. (See 1.9 Examining the power supply capacity)
   The power supply mode plug of the expansion interface module must be set according to the power supply module mounting status.
- If the long-distance type expansion is used, all expansion units should have the power supply modules.
- The dedicated expansion cables are available for the standard expansion and for the long-distance expansion, respectively.

## 1.3 Power supply module

The following table shows that two types of power supply modules are available, depending on the power supply voltage. These modules can be used for both the basic unit and the expansion unit. The power supply module is mounted in the extreme left of the rack. However, the expansion rack that is connected to the standard expansion IF may not need the power supply module. For details, see 1.9 Examining the power supply capacity.

Type	Rated voltage	Frequency
PS361	100-120 Vac/200-240 Vac (selectable)	50/60 Hz
PS332	24 Vdc	



#### POWER LED (green):

This LED is lit when the internal 5 Vdc power supply is normal.

For PS361...250 Vac-3A (with one spare fuse) For PS332...250 Vac-6A (with one spare fuse)

#### Run signal output terminals

Built-in NO contact which closes when T3 is in RUN mode. Contact output...240 Vac/24 Vdc-2A (max.) (can also be used on the expansion unit)

#### Voltage switch terminals :

These terminals are shorted or opened, depending on the power supply voltage (with a short-circuit bar).

100 to 120 Vac...short 200 to 240 Vac...open

#### Power supply input terminals:

These terminals are used to connect the power supply line.

#### Line filter ground terminal (LG):

This terminal is a neutral point for the primary line filter of the power supply. (grounding terminal)

#### Frame ground terminal (FG):

This terminal is connected to the frame of the T3. (grounding

The terminal is connected, via a capacitor, to the signal ground (SG) of the internal circuit.



- **CAUTION** (1) Correctly set the voltage switch terminals, otherwise the module will be damaged.
  - (2) For details, see 2.1 General Specifications, for the external power supply conditions.
  - (3) The screw size for the terminal is M3.5. For details of the wiring, see 4.5, Grounding, and 4.6, Wiring of the Power Supply.

1.4 CPU module

As shown in the table below, the CPU module is available in two types.

Type	Specification			
PU315 RAM (battery backup), 32K steps for user program, ladder diagram, SFC				
PU325	EEPROM+RAM (battery backup), 32K steps for user program, ladder diagram, SFC			

### PU315 / PU325 PU315 Status display LED (RUN, FAULT, I/O, BATT) FAULT ● BATT I/O ● ROM P RAM/ROM switch 0 Operation mode switch (HALT/RUN/P-RUN) BATTERY Battery cover RS232C port for the programmer (D-Sub 9-pin female connector) RS485 port for the computer link (D-Sub 15-pin female connector) IC memory card slot IC memory card ejection button Module fixing screw

### Status display LED:

RUN (green)	Lit	User program is executing (in the RUN mode)	
	Blink	Execution is stopped (in the HOLD mode)	
	Not lit	Execution is stopped (in the HALT mode or in the ERROR mode)	
	Lit	CPU/program error	
FAULT (red)	Blink	Hardware initialization error	
	Not lit	Normal	
	Lit	I/O error	
I/O (red)	Blink	Hardware initialization error	
( = =. <b>/</b>	Not lit	Normal	
BATT	Lit	Normal battery voltage	
(green)	Not lit	Battery voltage becomes low	

#### RAM/ROM switch:

Position at power ON	Type of CPU	Operation of the CPU (program transfer at power ON)		
RAM	PU315 PU325	Program transfer is not executed.		
	PU315	When an IC memory card which stores user program is inserted, contents of the IC memory card is transferred to RAM. (When the operation mode switch is in P-RUN, the program transfer is not executed.)		
		When an IC memory card is not inserted or when the IC memory card does not contain a user program, program transfer is not executed.		
ROM	PU325	When an IC memory card that stores user program has been inserted, contents of the IC memory card is transferred to RAM. (When the operation mode switch is in P-RUN, the program transfer is not executed.)		
		When an IC memory card is not inserted, or when the IC memory card inserted does not contain a user program, the contents of the EEPROM will be transferred to RAM. (When the operation mode switch is in P-RUN, the program transfer is not executed)		

By using the RAM/ROM switch and the operation mode switch together, the user can select a initial operation mode when power is applied. For details, see the next page.

#### Operation mode switch:

Position of the switch	Function		
HALT	User program execution is halted (HALT mode). Changing the operation mode by the programmer is invalid. Normally programming is done in this state.		
RUN	When the operation mode switch is changed to RUN, the user program execution is started (the RUN mode). Changing the operation mode from the programmer is possible.		
P-RUN	When the operation mode switch is changed to P-RUN, user program execution is started (the RUN mode). Changing the operation mode from the programmer is possible. The user program and leading 4K words of data registers (D) are write-protected.		

The table below shows the initial operation modes after power ON depending on the Operation mode switch and RAM/ROM switch status.

RAM/ROM switch	Mode switch	Mode after power on	Remarks	
	HALT	HALT		
RAM	RUN	HALT	The CPU module is started in the HALT mode and then waits for the RUN command from the programmer, or for a change-over of the operation mode switch (->HALT->RUN).	
	P-RUN	HALT		
	HALT	HALT	The user program is transferred in accordance with the conditions	
ROM	RUN	RUN	mentioned in the table on the preceding page.	
	P-RUN	RUN	The program transfer is not executed. The CPU module is started based on the contents of RAM.	



- (1) When power is turned on while the RAM/ROM switch is in RAM, user program execution will not be started. Regardless of the type of CPU module, therefore, the RAM/ROM switch should be set to ROM for normal operation.
- (2) When the Operation mode switch is changed to RUN while theRAM/ROM switch is in ROM, the program transfer is executed, according to the conditions mentioned in the table on the preceding page, before the CPU module starts operation.
- (3) For details on operation modes, see "T3 User's Manual-Functions" in a separate volume.

#### Battery cover:

A battery has been installed inside this cover at the factory shipment. The battery keeps the RAM contents (user program and user data) and supports the clock-calendar operation during power OFF.(See 5.4 Replacing battery)

#### RS232C port for the programmer:

The T-series programmer (T-PDS or HP911) is connected to the T3 through this port. Dedicated connection cables are available.

#### RS485 port for the computer link:

The CPU module has the computer link function as standard. By using this function, T3 can communicate with a host computer or an intelligent equipment through RS485 interface. For details of the computer link function, see separate "T-series Computer Link Funciton Operation Manual".

#### IC memory card slot:

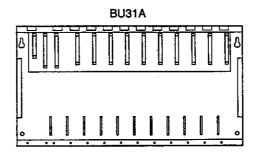
Optional IC memory card (type: ME914) is inserted into this slot. By installing the IC memory card, user program back-up/switchover or user data expansion become available. Refer to 5.6 IC memory card handling.

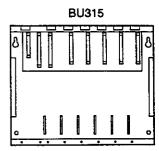
#### 1.5 Rack

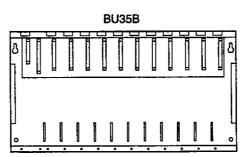
As described in the table below, in total four racks are available: two racks are for the basic unit, and two racks, for the expansion unit.

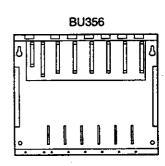
Type	Use	Number of modules mountable
BU31A	For	PS×1, IF×1, CPU×1, I/O×10
BU315	basic unit	PSX1, IFX1, CPUX1, I/OX5
BU35B	For	PSX1, IFX1, I/OX11
BU356	expansion unit	PSX1, IFX1, I/OX6

\*) "PS" and "IF" in the above table indicate the power supply module and the expansion interface module respectively.









The connector on the extreme-left slot of the rack is dedicated to the power supply module, and the connector next to the right slot is dedicated to the expansion interface module. The third connector from the extreme left slot of the basic unit rack (BU31A, BU315) is dedicated to the CPU module.

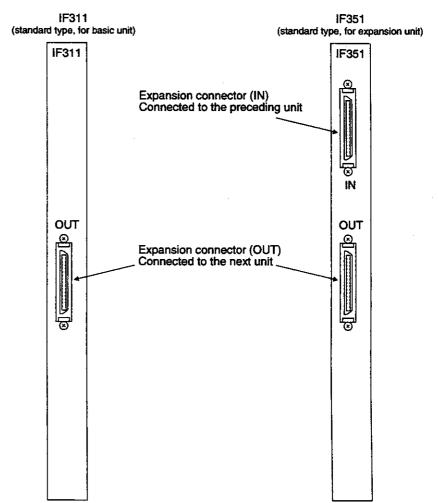


CAUTION Place a cap on each of the connectors where no module is mounted so that no foreign material will enter.

1.6 Expansion interface module

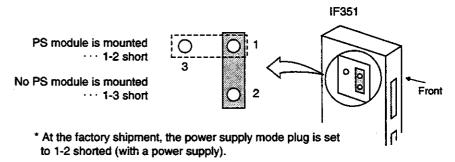
If the expansion units are used, the expansion interface modules must be mounted in each of the basic unit and the expansion units. There are basically two types of expansion interface modules-the standard type and the long-distance type. What type to use will depend on the cable distance. The dedicated expansion interface module must be mounted on each of the basic unit and the expansion units.

Туре	Use	Remark
IF311	For basic unit	Standard type
IF351	For expansion unit	2m maximum between two units, 6m maximum in total cable length
IF312	For basic unit	
IF352	For middle expansion unit	Long-distance type 40m maximum in total cable length
IF353	For end expansion unit	



- Since there is no compatibility between the standard type and the long-distance type, these two types cannot be mixed in one T3 configuration.
- The standard type expansion cable and the long-distance type expansion cable are not compatible with each other. (See Section 1.7 Expansion Cable.)
- If the standard type is used, whether a power supply module is necessary for the expansion unit will depend on the internal 5 Vdc current consumption. (See Section 1.9 Examining the power supply capacity.)

For the IF351, change the power supply mode plug as shown in the figure below (depending on whether a power supply module has been mounted on its own unit).



- For the long-distance type, a power supply module is needed for each of the expansion units.
- In the long-distance type, the IF312 is for basic unit, the IF352 is for middle expansion units and the IF353 is for the end expansion unit.

1.7 Expansion cable

The following types of expansion cables are available.

	Туре	Cable length	Remarks
1	CS3R5	0.5m	
2	CS301	1m	Standard type With both-end connectors (50-pin)
3	CS302	2m	The second contraction (see party
4	CL3R5	0.5m	
.5	CL301	1m	
6	CL305	5m	Long-distance type
7	CL310	10m	With both-end connectors (68-pin)
8	CL320	20m	
9	CL340	40m	

#### 1.8 **List of I/O Modules**

This manual explains the basic I/O modules in the list below and how to use them.

Туре		Specification
DI334		32 points (8 pts common), 12 to 24 Vdc, 10 mA/point
DI334H	DC	32 points (8 pts common), 12 to 24 Vdc, 10 mA/point, high-speed response
D1335	input	64 points (8 pts common), 24 Vdc, 5 mA/point
DI335H		64 points (8 pts common), 24 Vdc, 5 mA/point, high-speed response
IN354	AC	32 points (8 pts common), 100 to 120 Vac, 10 mA/point
IN364	input	32 points (8 pts common), 200 to 240 Vac, 10 mA/point
DO333		16 points (8 pts common), 12 to 24 Vdc, 2 A/point, 5 A/common
DO334	DC output	32 points (16 pts common), 12 to 24 Vac, 0.5 A/point, 5 A/common
DO335		64 points (8 pts common), 5 to 24 Vdc, 100 mA/point
AC363	AC	16 points (8 pts common), 100 to 240 Vac, 2 A/point, 5 A/common
AC364	output	32 points (16 pts common), 100 to 240 Vac, 0.5 A/point, 3.2 A/common, 5 A/module
RO364	Relav	32 points (8 pts common), 240 Vac/24 Vdc, 2 A/point, 5 A/common
RO363S	output	16 points (isolated contact), 240 Vac/24 Vdc, 2 A/point

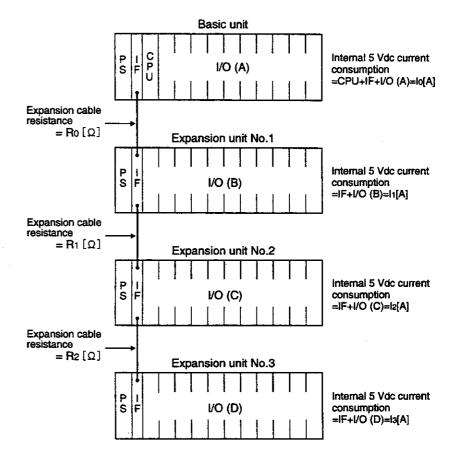
- For details on the specification of I/O modules, see 2.3, I/O module specifications.
- Carefully read the Cautions described in Section 3 for applying I/O modules.
- The I/O module can be mounted in any I/O slot functionally. However, to improve noise-immunity for the entire system, it is recommended to separate the low voltage I/Os and the power I/Os. (See 4.7, I/O Wiring.)

# 1.9 Examining the power supply capacity

The maximum output current (5 Vdc) of the power supply module (PS361/PS332) is 7 A. (5.1V at factory setting)

In the standard type expansion configuration, if the power supply module of the previous unit can supply 5 Vdc to the following units, no power supply module for the following expansion units is necessary.

In this case, however, there may be a voltage drop of the 5 Vdc power caused by the resistance of the expansion cable. The minimum limit voltage is 4.75 Vdc. It should also be considered.



Concerning the above figures, the following conditions (1) and (2) must be satisfied so that the expansion units NO.1 through 3 can be mounted in the slots using no power supply of their own.

- (1)  $i_0+i_1+i_2+i_3 < 7A$
- (2)  $5.1-R_0 \times (|1+|2+|3)-R_1 \times (|1+|3)-R_2 \times |3 > 4.75V$

If either of the above conditions is not satisfied, a power supply module is needed for the expansion unit.

If a power supply module is mounted on the expansion unit, the power supply module will supply 5 Vdc to the own unit and to the following expansion units, disconnecting 5 Vdc line from the previous unit (0V line is common).

For example, if the user is going to mount a power supply module on the expansion unit No.2, check that the following conditions are satisfied.

) Conditions for the power supply  $(1) l_{0}+l_{1} < 7A$ (2) 5.1-R<sub>0</sub> $\times$ I<sub>1</sub> > 4.75V  $\int$  capacity of the basic unit Conditions for the power supply (3) 12+13 < 7A(4) 5.1-R2×I3 > 4.75V capacity of expansion unit No.2

Additional power supply modules may be mounted on the units even though the power supply capacity has enough margin.



- (1) Correctly set the power supply mode plug of the expansion interface module (IF351) according to a power supply module to be mounted on the unit. If the setting is wrong, the T3 will not work normally. (For details, see 1.6 Expansion interface module.)
- (2) For the long-distance expansion interface module, each of the units must be equipped with a power supply module.

The table below shows the resistance values (typical value) of expansion cables.

Cable length	Part No.	Resistance value	Remarks
0.5m	CS3R5	<b>38</b> mΩ	Standard type
1m	CS301	<b>66m</b> Ω	With both-end connectors (50-pin)
2m	CS302	112mΩ	(00 pmy

The table below lists the internal 5 Vdc current consumption (max.) of the module for calculating allowable power capacity.

Туре	Name	Part No.	internal 5- volt current consumption	
	Standard expansion interfa (for basic unit)	IF311	20 mA	
1	Standard expansion interfation (for expansion unit)	ace	IF351	20 mA
Expansion interface	Long-distance expansion i (for basic unit)	nterface	<del>IF</del> 312	800 mA
	Long-distance expansion i (for middle expansion unit)	nterface	IF352	700 mA
	Long-distance expansion i (for end expansion unit)	nterface	IF353	700 mA
CPU	CPU (RAM)		PU315	2.5 A
CFU	CPU (EEPROM+RAM)		PU325	2.5 A
	32-point DC input		DI334	100 mA
DC	32-point DC input (high-speed response)		DI334H	100 mA
input	64-point DC input		DI335	170 mA
	64-point DC input (high-speed response)	DI335H	170 mA	
AC	32-point AC input (100 to	IN354	120 mA	
input	32-point AC input (200 to 2	IN364	120 mA	
50	16-point DC output (12 to	DO333	320 mA	
DC output	32-point DC output (12 to	DO334	210 mA	
	64-point DC output (5 to 2	DO335	400 mA	
AC	16-point AC output (100 to	AC363	530 mA	
output	32-point AC output (100 to	240 Vac)	AC364	800 mA
Relay	32-point relay output	······	RO364	170 mA
outpút	16-point relay output (isola	ited)	RO363S	100 mA
	Analog input (8 channels)		AD368	450 mA
	Analog output	Voltage	DA364	180 mA
Special	(4 channels)	Current	DA374	180 mA
1/0	Pulse input (2 channels)		Pl312	800 mA
	DC input (8 pts) with statu detection	CD332	300 mA	
	ASCII interface		AS311	-1 A
		Coaxial	SN321	800 mA
Data link	TOSLINE-S20	Optic	SN322	800 mA
	` [	Coaxial/optic	SN323	800 mA
	TOSLINE-F10 (master)	MS311	1 A	

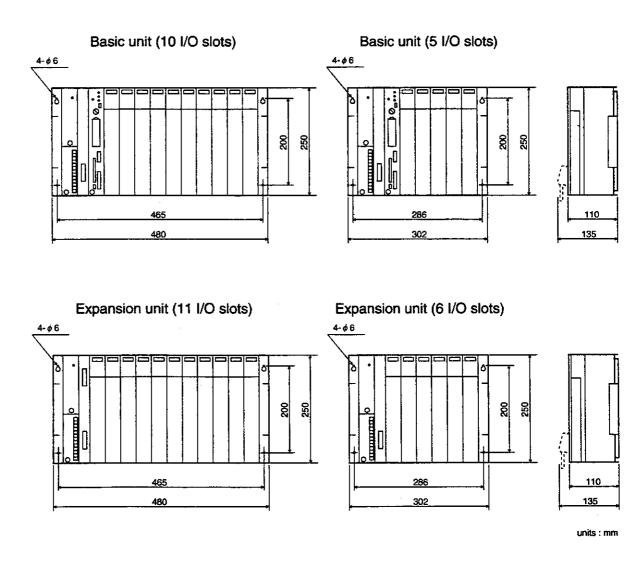
Note) The current consumption of the T3 CPU modules (2.5 A max.) is the value when the handy programmer (HP911) is connected. When the HP911 is not connected, it is 1.5 A max.

### 2. Specification

### 2.1 General Specifications

	Item	Specification	Remarks
	Rated	(1) 100 to 120 Vac/200 to 240 Vac	Switchable
	voltage	(2) 24 Vdc	
	Voltage	(1) 85 to 132 Vac/170 to 264 Vac	
	tolerance	(2) 20.4 to 28.8 Vdc	
pply	Rated frequency	(1) 50/60 Hz	
Power supply	Frequency tolerance	(1) 47 to 63 Hz	
Po	Retentive power interruption	10 ms or less	
	Power	(1) 80 VA or less	Max. load conditions of one
	consumption	(2) 50 W or less	PS module
į	Inrush	(1) 10 A/100 Vac, 20 A/200 Vac	
	current	(2) 6 A	·
	nsulation esistance	10 MΩ or more (500 Vdc)	Between power terminals and FG
-	/ithstand oltage	1500 Vac for 1 minute	Between power terminals and FG
	perating emperature	0 to 55℃	
	torage emperature	-20 to 75°C	
	mbient umidity	20 to 90% RH	No condensation
A	tmosphere	No corrosive gases	
D	ust	10 mg/m³ or less	
	ibration nmunity	16.7 Hz, 3 mmp-p, 30 seconds	No power
	hock 98 m/s², 3 times, in X, Y, Z nmunity directions		No power
	loise nmunity	1500 Vp-p, 1 $\mu$ s (noise simulator method) NEMA ICS3-304	Power supply noise
G	Prounding	100Ω or less	
S	tructure	Control panel built-in type	
c	Cooling	Natural cooling	
V	Veight	Approx. 7.6 kg	Basic unit with 10 I/O modules
		Approx. 4.7 kg	Basic unit with five I/O modules

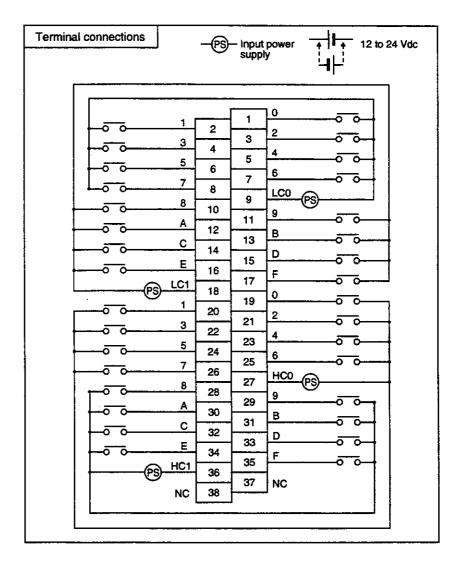
2.2 **External Dimensions** 



2.3 I/O module specifications 32-point DC input

Туре		DI334	DI334H
Category		DC input	
input type		Current sinking/sourcing	
Number of input points		32 points, 2-word input (X 2 W)	
Insulating method		Photo-coupler	
Rated input voltage		12 to 24 Vdc	
Range of input voltage		10 to 26.4 Vdc	
Rated input current		10 mA (at 24 Vdc)	
Input impedance		2.4 KΩ (at 24 Vdc)	
Opera- tion	Min. ON voltage	9.6V	
	Max. OFF voltage	3.5V	
Delay	OFF → ON	10 ms or less	1 ms or less
	ON → OFF	15 ms or less	1.5 ms or less
Input signal display		LED display for all points, lit at ON, internal logic side	
External connection		38-pin removable terminal block, M3.5	
No. of commons		4 (insulated between commons)	
No. of input points per common		8 points/common	
Polarity of common		No Polarity	
Derating condition		See NOTE on the next pate	
Internal current consumption		5 Vdc, 100 mA or less	
Insulation resistance		10 MΩ or more (500 Vdc)	
Withstand voltage		1500 Vac, 1 minute (between commons, between internal and external circuits)	
Weight		420g	
Internal circuit			
0 0			Internal circuit

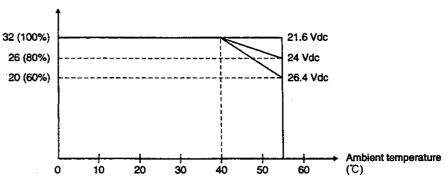
# 32-point DC input (cont'd)





The number of simultaneous ON input points will be restricted according to the ambient temperature and input voltage, as described in the figure below.

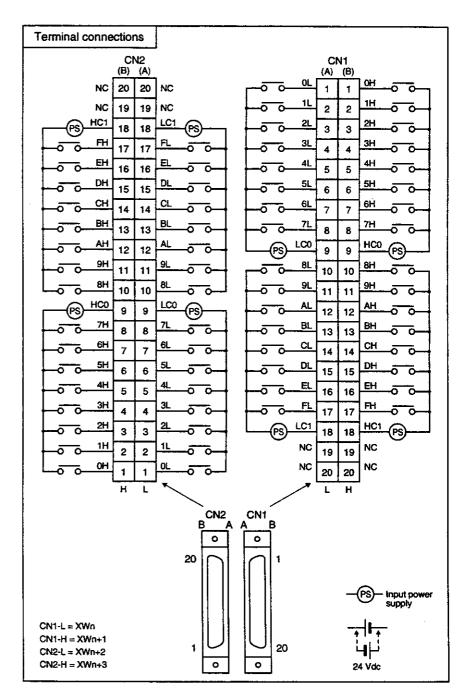
Number of simultaneous ON input points



## 64-point DC input

Time		DI335	Dissell
	Type		DI335H
Category		DC input	
Input type		Current sinking/sourcing	
· ··-	of input points	64 points, 4-word input (X	4 W)
<del></del>	g method	Photo-coupler	
	put voltage	24 Vdc	
<u>-</u>	f input voltage	18 to 26.4 Vdc	
Rated in	put current	5 mA (at 24 Vdc)	
Input imp		4.8 KΩ (at 24 Vdc)	
Opera- I	Min. ON voltage	16V	
voltage	Max. OFF voltage	5V	
Delay	OFF → ON	10 ms or less	1 ms or less
	ON → OFF	15 ms or less	1.5 ms or less
Input sig	nal display	LED display for all points,	lit at ON, internal logic side
External	connection	Connector (40-pin)×2	
No. of co	ommons	8 (insulated between com	mons)
No. of in per com	put points mon	8 points/common	
Polarity	of common	No Polarity	
Derating	condition	As same as DI334/DI334H	
Internal consump		5 Vdc, 170 mA or less	
Insulatio	n resistance	10 MΩ (500 Vdc)	
Withstar	nd voltage	1500 Vac, 1 minute (between internal and exte	ernal circuits)
Weight		600g (including connector	s)
Internal	circuit		
CN <sup>2</sup>	LC1 0		Internal circuit

# 64-point DC input (cont'd)





Type of the connector of the module side: FCN-365P040-AU (Fujitsu)

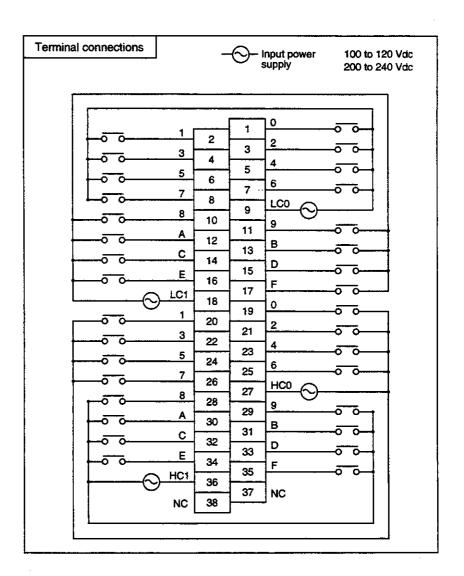
Connectors (2, soldering types) of the cable side are attached as standard.

## 2. Specification

## 32-point AC input

	Time	INIOEA	1004
Туре		IN354	IN364
Category		AC input	
Number of input points		32 points, 2-word input (X 2 W)	
	ng method	Photo-coupler	
-	nput voltage	100 to 120 Vac	200 to 240 Vac
Range	of input voltage	85 to 132 Vac	170 to 264 Vac
Freque	ncy	50/60Hz (47 to 63Hz)	
Rated in	nput current .	10 mA (at 100 Vac, 50Hz)	10 mA (at 200 Vac, 50Hz)
Input in	npedance	10 KΩ (50Hz), 8 KΩ (60Hz)	22 kΩ (50 Hz), 18 kΩ (60 Hz)
Opera- tion	Min. ON voltage	70 Vac	140 Vac
	Max. OFF voltage	25 Vac	50 Vac
Delay	OFF → ON	15 ms or less	
Dolay	ON → OFF	15 ms or less	
Input si	gnal display	LED display for all points,	lit at ON, internal logic side
Externa	l connection	38-pin removable terminal	block, M3.5
No. of c	commons	4 (insulated between comm	mons)
No. of i	nput points nmon	8 points per common	
Deratin	g condition	None	
Internal consum	current option	5 Vdc, 120 mA or less	
Insulati	on resistance	10 MΩ or more (500 Vdc)	
Withstand voltage		1500 Vac, 1 minute (between internal and external circuit	een commons, between its)
Weight		480g	
Internal circuit			
0			Internal circuit

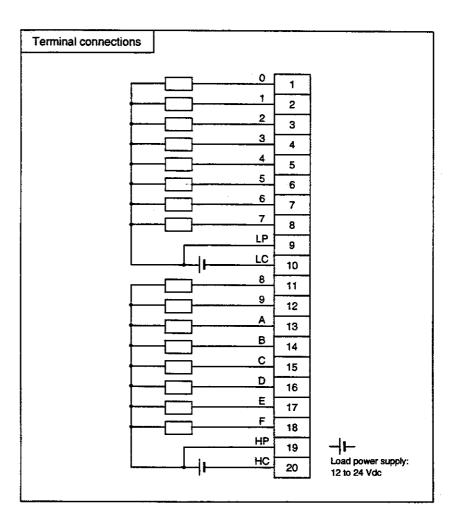
32-point AC input (cont'd)



## **16-point DC output**

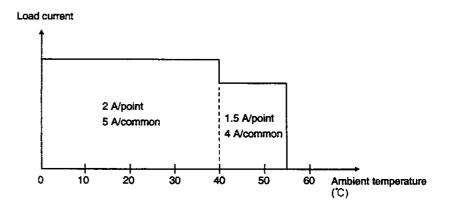
Туре		DO333
		Transistor output
Category		Current sinking
Output type  No. of output points		16 points, 1-word input (Y 1 W)
	ng method	Photo-coupler
	nput voltage	12 to 24 Vdc
	of load voltage	10 to 30 Vdc
-	pad current	2 A/point, 5 A/common
Voltage	drop at ON	1.5 V or less (at 24 Vdc)
Leakag	e current at OFF	0.1 mA or less (at 24 Vdc)
Delay	OFF → ON	1 ms or less
	ON → OFF	1 ms or less
Output	signal display	LED display for all points, lit at ON, internal logic side
Module	status display	Fusing/external abnormal power supply LED (FL, FH), lit at abnormal state
Externa	l connection	20-pin removable terminal block, M3.5
No. of c	commons	2 (insulated between commons)
No. of c	output points nmon	8 points per common
Commo	on polarity	negative (-) polarity
Deratin	g condition	See NOTE on the next page
Internal consum	current option	5 Vdc, 320 mA or less
Insulation	on resistance	10 MΩ (500 Vdc)
Withsta	nd voltage	1500 Vac, 1 minute (between commons, between internal and external circuits)
Built-in	fuse	6 A/common×2
Surge s	suppressor	Diode
Weight		410g
Internal circuit		
LED display Internal circuit		Fusing detection circuit  O 0  O 7  O LP  O LC  (6A)  O 8  O F  O HP  O HC  (6A)

16-point DC output (cont'd)



NOTE

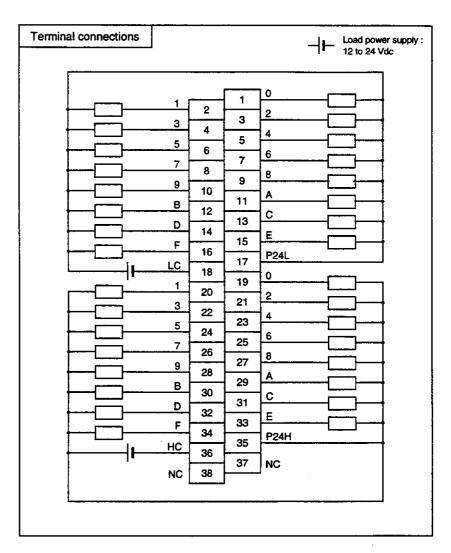
The maximum load current has the following restrictions, depending on the ambient temperature.



## 32-point DC output

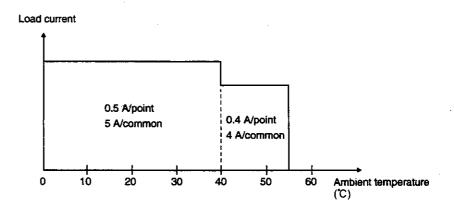
Туре		DO334
Category		Transistor output
Output type		Current sinking
No. of c	output points	32 points, 2-word output (Y 2 W)
Insulati	ng method	Photo-coupler
Rated le	oad voltage	12 to 24 Vdc
Range	of load voltage	10 to 30 Vdc
Max. Id	oad current	0.5 A/point, 5 A/common
Voltage	drop at ON	1.5 V or less
Leakag	e current at OFF	0.1 mA or less (at 24 Vdc)
Delay	OFF → ON	1 ms or less
Delay	ON → OFF	1 ms or less
Output	signal display	LED display for all points, lit at ON, internal logic side
Module	status display	Fusing/external abnormal power supply LED (FL, FH), lit at abnormal state
Externa	l connection	38-pin removable terminal block, M3.5
	ommons	2 (insulated between commons)
No. of c	output points nmon	16 points per common
Commo	n polarity	negative (-) polarity
·	g condition	See NOTE on the next page
Internal consum	current ption	5 Vdc, 210 mA or less
Insulation	on resistance	10 MΩ (500 Vdc)
Withsta	nd voltage	1500 Vac, 1 minute (between commons, between internal and external circuits)
Built-in	fuse	6 A/common×2
Surge s	uppressor	Diode
Weight		530g
Internal circuit		
d	internal circuit	Fusing detection circuit  Fusing detection c

# 32-point DC output (cont'd)





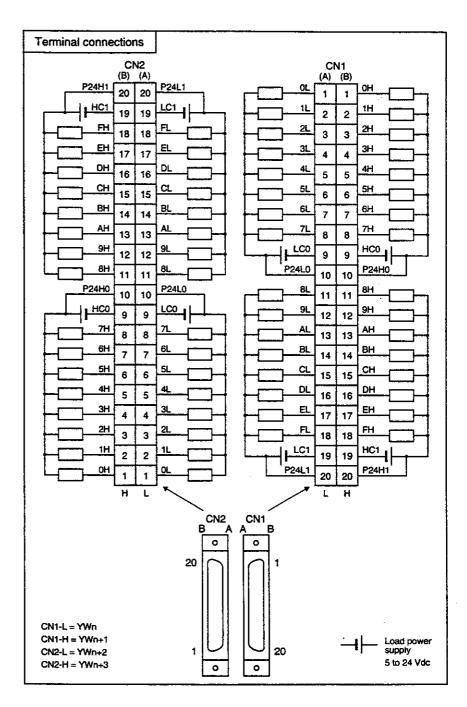
Maximum load current has the following restrictions, depending on the ambient temperature.



## 64-point DC output

Туре	DO335
Category	Transistor output
Output type	Current sinking
No. of output points	64 points, 4-word output (Y 4 W)
Insulating method	Photo-coupler
Rated input voltage	5 Vdc/12 to 24 Vdc
Range of load voltage	4.5 to 9.5 Vdc/9.6 to 26.4 Vdc
Max. load current	0.1 A/point (9.6 to 26.4 Vdc) 0.05 A/point (4.5 to 9.5 Vdc)
Voltage drop at ON	0.4 V or less
Leakage current at OFF	0.1 mA or less (at 24 Vdc)
OFF → ON	1 ms or less
ON → OFF	1 ms or less
Output signal display	LED display for all points, lit at ON, internal logic side
Module status display	None
External connection	40-pin connector×2
No. of commons	8 (insulated between commons)
No. of output points per common	8 points per common
Common polarity	negative (-) polarity
Derating condition	None
Internal current consumption	5 Vdc, 400 mA or less
Insulation resistance	10 MΩ or less (500 Vdc)
Withstand voltage	1500 Vac, 1 minute (between internal and external circuits)
Built-in fuse	None
Surge suppressor	Diode
Weight	550g (including connectors)
Internal circuit	
LED display  Internal circuit	O P24L0 O D LC0 O P24L1 O BL O BL O P24H0 O O H O O P24H1 O O P24H1 O P24H1 O P24H1 O P24H1 O P24H1 O O P24L1 O HC1 O P24L0 CN2

#### **64-point DC output** (cont'd)





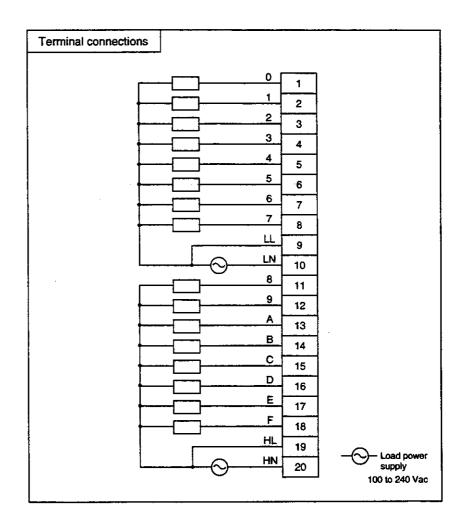
Type of the connector on the module side: FCN-365P040-AU (Fujitsu)

The connectors (two, soldering types) of the cable side are attached as standard.

## 16-point AC output

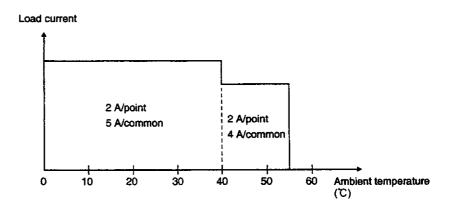
Туре		AC363
Category		Triac output
No. of output points		16 points, 1-word output (Y 1 W)
Insulati	ng method	Photo-coupler
Rated k	oad voltage	100 to 240 Vac (50/60 Hz)
Range	of load voltage	24 to 264 Vac (47 to 63 Hz)
Max. Ic	ad current	2 A/points, 5 A/common
Voltage	drop at ON	1.5 V or less
Leakag	e current at OFF	1.0 mA or less (at 100 Vac, 50 Hz) 2.4 mA or less (at 200 Vac, 60 Hz)
Min. loa	d current	100 mA (24 Vac), 50 mA (100 to 240 Vac)
Max. in	rush current	20 A/20 ms (point), 40 A/20 ms (common)
Delay	OFF → ON	1 ms or less
Delay	ON → OFF	1 ms+1/2cycle or less
Output	signal display	LED display for all points, lit at ON, internal logic side
Module	status display	Fusing display LED (FL, FH), lit at fusing
Externa	il connection	20-pin removable terminal block, M3.5
No. of c	commons	2 (insulated between commons)
No. of o	output points nmon	8 points per common
Deratin	g condition	See NOTE on the next page
Internal consum	current option	5 Vdc, 530 mA or less
Insulati	on resistance	10 MΩ or less (500 Vdc)
Withsta	ind voltage	1500 Vac, 1 minute (between commons between internal and external circuits)
Built-in	fuse	6 A/common×2
Surge s	suppressor	CR snubber circuit, varistor
Weight		500g
Interna	circuit	
d	Internal circuit	Fusing detection circuit

16-point AC output (cont'd)



NOTE

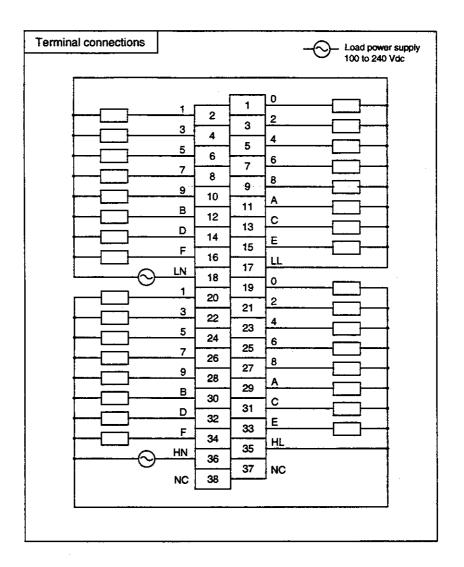
Maximum load current has the following restrictions, depending on the ambient temperature.



## 32-point AC output

Туре		AC364
Category		Triac output
No. of output points		32 points, 2-word output (Y 2 W)
Insulati	ng method	Photo-coupler
Rated in	oad voltage	100 to 240 Vac (50/60 Hz)
Range	of load voltage	24 to 264 Vac (47 to 63 Hz)
Max. Id	ad current	0.5 A/point, 3.2 A/common, 5 A/module
Voltage	drop at ON	1.5 V or less
Leakag	e current at OFF	0.8 mA or less (at 100 Vac, 50 Hz) 1.6 mA or less (at 200 Vac, 50 Hz)
Min. loa	d current	100 mA (24 Vac), 50 mA (100 to 240 Vac)
Max. in	rush current	20 A/20 ms (points and common)
Delay	OFF → ON	1 ms or less
Delay	ON → OFF	1 ms+1/2cycle or less
Output	signal display	LED display for all points, lit at ON, internal logic side
Module	status display	Fusing display LED (FL, FH), lit at fusing
Externa	l connection	38-pin removable terminal block, M3.5
No. of c	commons	2 (insulated between commons)
No. of o	output points nmon	16 points per common
Deratin	g condition	None
Internal consum	current option	5 Vdc, 800 mA or less
Insulati	on resistance	10 MΩ or less (500 Vdc)
Withsta	nd voltage	1500 Vac, 1 minute (between commons, between internal and external circuits)
Built-in	fuse	6 A/common×2
Surge s	suppressor	CR snubber circuit
Weight		540g
Interna	circuit	
d	Internal circuit	Fusing detection circuit (6A)  Fusing detection circuit (6A)

# 32-point AC output (cont'd)



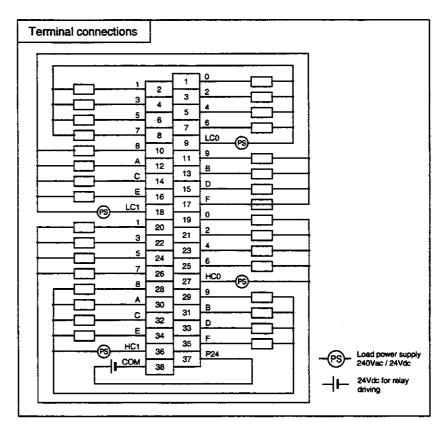


Minimum 24 Vac can be used as the load voltage. However, if load voltage becomes 85 Vac or less, the fusing detection circuit may work. In this case, although AC output operation has no problem, the fusing display LED (FL, FH) will light.

## 32-point relay output

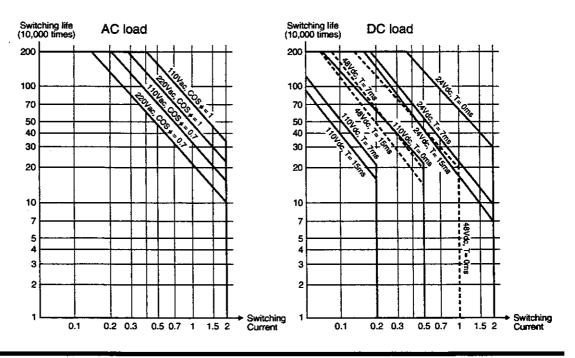
Type		RO364
Category		Electromechanical relay output
Output type		NO-contact
No. of ou	Itput points	32 points, 2-word output (Y 2 W)
Insulatin	g method	Photo-coupler
Rated lo	ad voltage	240 Vac/24 Vdc
Range o	f load voltage	Up to 264 Vac/125 Vdc
Max. loa	ad current	2 A/point (resistive load), 5 A/common
Contact	ON resistance	50 mΩ or less (initial value)
Leakage	current at OFF	None
Min. load	d current	5 Vdc, 10 mA (50 mW or more)
Delay	OFF → ON	10 ms or less
Delay	ON → OFF	10 ms or less
Output s	ignal display	LED display for all points, lit at ON, internal logic side
Module s	status display	Abnormal external power supply display LED (F), lit at abnormal state
External	connection	38-pin removable terminal block, M3.5
No. of co	ommons	4 (insulated between commons)
No. of ou per comi	tput points mon	8 points per common
internal c		5 Vdc, 170 mA or less
External	Rated voltage	24 Vdc
power for relay	Rated current	300 mA (24 Vdc, at all points ON)
101 Telay	Voltage range	21.6 to 26.4 Vdc
Mechani	cal life	20 million times or more
Electrica	l contact life	See the next page
Insulatio	n resistance	10 M $\Omega$ or more (500 Vdc)
Withstan	d voltage	1500 Vac, 1 minute (between commons, between internal and external circuits)
Built-in f	use	None
Weight		510g
Internal circuit		
	LED display	0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0
		detection circuit OCOM

# 32-point relay output (cont'd)





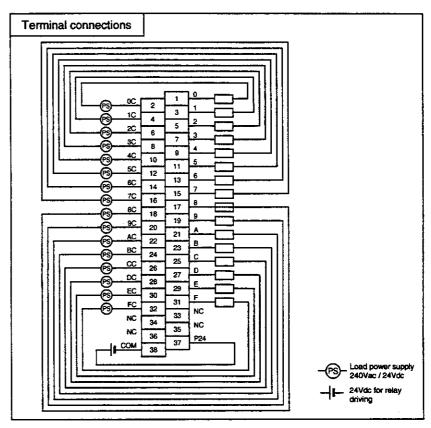
The following figures indicate life curves of the output relay. The data are based on 1800 switching times/hour. For more frequently operation, the life of the output relay will become shorter.



# 16-point isolated relay output

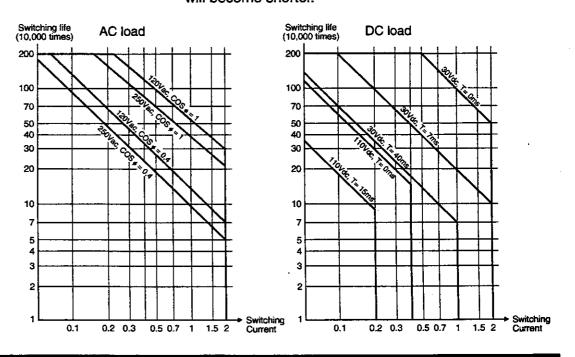
Type //pe //pe utput points g method ad voltage fload voltage ad current ON resistance current at OFF d current	RO363S  Electromechanical relay output  NO-contact  16 points, 1-word output (Y 1 W)  Photo-coupler  240 Vac/24 Vdc  Up to 264 Vac /125 Vdc  2 A/point  50 mΩ or less (initial value)  None	
rpe utput points g method ad voltage f load voltage ad current ON resistance current at OFF	NO-contact  16 points, 1-word output (Y 1 W)  Photo-coupler  240 Vac/24 Vdc  Up to 264 Vac /125 Vdc  2 A/point  50 mΩ or less (initial value)  None	
atput points g method ad voltage f load voltage ad current ON resistance current at OFF	16 points, 1-word output (Y 1 W) Photo-coupler 240 Vac/24 Vdc Up to 264 Vac /125 Vdc 2 A/point 50 mΩ or less (initial value) None	
g method ad voltage f load voltage ad current ON resistance current at OFF	Photo-coupler  240 Vac/24 Vdc  Up to 264 Vac /125 Vdc  2 A/point  50 mΩ or less (initial value)  None	
ad voltage f load voltage ad current ON resistance current at OFF	240 Vac/24 Vdc Up to 264 Vac /125 Vdc 2 A/point 50 mΩ or less (initial value) None	
f load voltage ad current ON resistance current at OFF	Up to 264 Vac /125 Vdc 2 A/point 50 mΩ or less (initial value) None	
ad current ON resistance current at OFF	2 A/point 50 mΩ or less (initial value) None	
ON resistance current at OFF d current	50 mΩ or less (initial value) None	
current at OFF	None	
d current		
	E \/do 10 m \ /E0 m\\/ a=\	
	5 Vdc, 10 mA (50 mW or more)	
	10 ms or less	
ON → OFF	10 ms or less	
ignal display	LED display for all points, lit at ON, internal logic side	
status display	Abnormal external power supply display LED (F), lit at abnormal state	
connection	38-pin removable terminal block, M3.5	
	16-point isolated contact	
	5 Vdc, 100 mA or less	
Rated voltage	24 Vdc	
Rated current	145 mA (24 Vdc, at all points ON)	
Voltage range	21.6 Vdc to 26.4 Vdc	
cal life	20 million times or more	
l contact life	See the next page	
n resistance	10 MΩ or more (500 Vdc)	
d voltage	1500 Vac, 1 minute (between the points, between internal and external circuits)	
ıse	None	
·	450g	
circuit		
	O C O C O C O C O C O C O C O C O C O C	
	ignal display status display connection connection current otion Rated voltage Rated current Voltage range cal life I contact life n resistance d voltage use circuit	

# 16-point isolated relay output (cont'd)





The following figures indicates life curves of the output relay. The data are based on 1800 switching times/hour. For more frequently operation, the life of the output relay will become shorter.

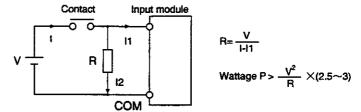


# 3.1 Precautions for DC input modules

(1) Read conditions for the ON/OFF changes of the input signals are: Input ON time ≥ON delay time (OFF->ON)+Input reading cycle Input OFF time ≥OFF delay time (ON->OFF)+Input reading cycle

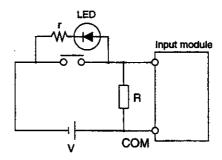
Where the "input reading cycle" means PLC scan cycle for the refresh input, or the execution interval of a direct input instruction when the instruction is used.

(2) For some external contacts, the input current (10 mA/24V for DI334; 5 mA/24V for DI335) of modules may not be able to maintain contact reliability. In this case, install a bleeder resistor between the input and common terminals to increase the contact current.



(An example of selecting a bleeder resistor R) Input voltage V=24 Vdc Input module DI334 (10 mA/24 Vdc) When the contact requires 50 mA current; Resistance value R of a bleeder resistor=0.6[k $\Omega$ ] Wattage P of the bleeder resistor=3[W]

(3) If a switch with an LED display is used, the current (leakage current) through the LED may cause the erroneous input (always ON). In this case, install a bleeder resistor to lower the input impedance.



(Example of selecting a bleeder resistor R)
When the voltage between input terminals is Vd at the switch
OFF state (with no bleeder resistor), the resistance (R) and the
wattage (P) of the bleeder resistor can be selected as follows.

$$R < \frac{(V-Vd) Vo}{V(Vd-Vo)} \cdot Zi$$

$$P = (2.5 \sim 3) \cdot \frac{V^2}{R}$$

V: Input voltage

Vo: Max. OFF voltage of the input module Zi: Input impedance of the input module

In case of DI334,

V=24 Vdc, Vo=3.5 Vdc, Zi=2.4  $k\Omega$ 

If Vd=5 Vdc, R can be calculated as follows.

$$\mathsf{R}[\mathsf{k}\Omega] < \frac{(24\text{-}5)\times3.5}{24\times(5\text{-}3.5)}\times2.4[\mathsf{k}\Omega]$$

As a result,

$$R<4.4[k\Omega]->3k\Omega$$

$$P=(2.5\sim3)\times\frac{(24[V])^2}{3000[\Omega]}\to 0.5W$$

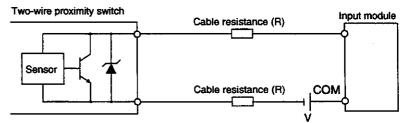
Also, when the bleeder resistor is selected in the above manner. the contact current at the switch ON state should be checked.

Contact current=24[V]
$$\times \frac{2.4[k\Omega]+R}{2.4[k\Omega]\times R}$$
 =18[mA]

(4) If the two-wire proximity switch and other solid-state switches are used, be sure that there is no possibility of mis-inputting because of the leakage current, as in procedure (3). (See (3) for details on how to select a bleeder resistor.) Also in this case, because of the effect of the saturation voltage

(voltage drop) at ON, regardless of whether the switch is ON, the input terminal voltage may not be able to reach the ON voltage, thereby failing to read as input ON.

If input voltage is low or if input wiring is too long, special measures are necessary.

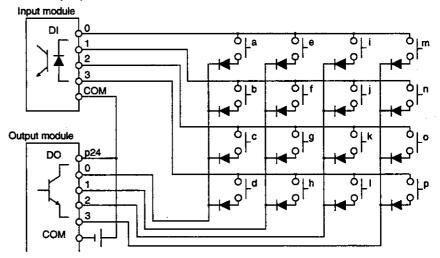


If the cable resistance value is expressed as  $R[\Omega]$ , Vd[V] for the voltage drop of the proximity switch, and  $Zi[\Omega]$  for the input impedance of the input module, the voltage Vi[V] applied between the input module terminals will be as expressed below (when the proximity switch is ON):

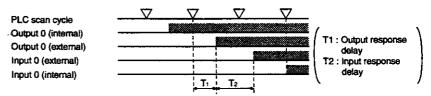
$$V_{i=} \frac{V - V_{d}}{2R + Z_{i}} \quad Z_{i}$$

If the above Vi is lower than the minimum ON voltage of the input module, input voltage V must be raised or the value of the cable resistor R must be made smaller.

- (5) Because the input filter time constant of the high-speed response input module (DI334H, DI335H) is set to small, the input module may read the wrong input due to chattering of the contact. Use the high-speed response input module to connect with solid-state devices. Also, take measures to suppress noise.
- (6) If input wiring is too long, take measures to prevent erroneous input caused by noise, as follows.
  - Wiring length must be minimized. Do not make unnecessary loops.
  - Keep the input wires away, at least 200 mm, from power cables and high frequency lines, or shield the input cables with a metal plate.
  - If possible, use relays at the leading in the control panel.
  - For some cases, use a shielded cable or twisted-pair cable.
  - •Install a bleeder resistor to reduce input impedance.
- (7) If dynamic scan input is configured using a DC input module and a DC output module, in addition to the response-delay of output and input, consider the difference of timing caused by the PLC scan. Moreover, diodes must be installed to prevent erroneous input caused by detour circuit. (the figure below is an example of  $4\times4$  input)



For example, when contact a is ON, the change timing between output 0 and input 0 is as follows:



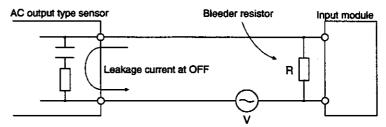
Note that the change timing of output 0 and input 0 will be affected with the scan time of the PLC and the response time of input and output.

# Precautions in applying AC input modules

- (1) The conditions to read the ON/OFF state of the input signal are as follows:
  - Input ON time≧ON delay time (OFF->ON)+Input reading cycle
    Input OFF time≧OFF delay time (ON->OFF)+Input reading
    cycle

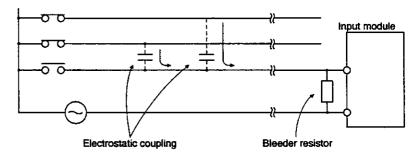
The input reading cycle means PLC scan cycle for the refresh input, or the execution interval of the direct input instruction when using a direct input instruction.

(2) When an AC output sensor is connected to the I/O module, due to the leakage current from the sensor at OFF, there may be a voltage which exceeds the maximum OFF voltage between the input terminals. This will make the PLC unable to read input OFF when the sensor is OFF. In this case, install a bleeder resistor between the input terminals to lower the input impedance.

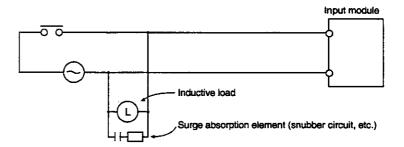


For selecting a bleeder resistor, refer to 3.1 (3).

(3) If external lines for AC input become longer with using a multi-core cable, induced current may flow to an open wire from charged wires due to the electrostatic capacity of the cable, causing an erroneous ON input. In this case, install a bleeder resistor between the input terminals to lower the input impedance. Or, you had better apply the DC input.



- (4) If the AC lines are installed in parallel with high frequency or power lines, induced current may cause erroneous input. In this case, take necessary countermeasures as follows:
  - Change the installation route of AC input lines so that they are not parallel with power lines and high frequency lines.
  - Use twisted-pair cables as input lines.
  - Use shielded cables as input lines.
  - Use relays at the leading in the control panel (the relay must satisfy larger ON current).
  - Install a bleeder resistor to lower the input impedance.
- (5) If the input module and an inductive load are connected in parallel, a surge voltage generated at both-ends of the load when the contact is changed to OFF may cause a malfunction of the PLC. In this case, install a surge absorption element in parallel with the load to suppress the surge voltage.



#### 3.3 **Precautions for DC** output modules

(1) The DC output module needs an external power supply to drive output transistors. For each common, connect the load power to the appropriate terminal. (For details, see 2.3, I/O module specifications)

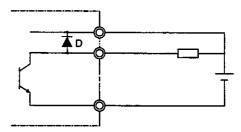
If the wrong polarity of the power supply to the terminal is connected, the module will be damaged. Check the polarity before connection.

For the DO333 and DO334 modules, if their built-in fuse is blown out or if the external power supply is not supplied, the front LED (FL, FH) of the module lights.

(2) Protection coordination against over-current of DC output module

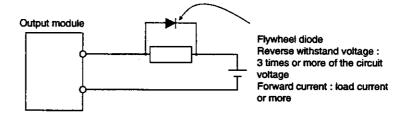
Type of module	Protection
DO333	A fuse of 6 A per common (8 points) is built in this DC
(16-point output)	output module. For an overload and load short-cir
	cuit, the transistor will not be protected. This fuse,
	however, protects the DC output module and the
	external cable from burn-out.
DO334	A fuse of 6 A per common (16 points) is built in this DC
(32-point output)	output module. For an overload and load short-circuit,
(	the transistor will not be protected. This fuse, however,
	protects the module and the external cable from burn-
	out.
DO335	Because a protection fuse is not built in this DC output
(64-point output)	module, the load short-circuit, etc. will cause burn-out
(64-point output)	of the module and external cable, Therefore, install an
	appropriate fuse on the outside to prevent accidental
	burn-out.
· · · · · · · · · · · · · · · · · · ·	puin-out.

(3) A diode as shown in the figure below is built in to protect the transistor from transient overvoltage.



D: Bypasses transient overvoltage to the power supply and suppresses the voltage between the collector and emitter of the transistor.

- (4) If a capacitive load is connected, rush current will flow when output is changed to ON. At that time, necessary measures must be taken to protect the output transistor from being destroyed by the rush current. To limit the rush current there are two effective measures. One is to connect a resistor to the load in series. The other is to apply dummy current to the load by connecting a resistor between the output terminals.
- (5) If an inductive load is connected, transient overvoltage will occur when the output is changed to OFF. This surge voltage will be absorbed into the diode D mentioned before so that the transistor will be protected. However, if the output cable is installed closely to other signal lines, the surge voltage may cause other problem. In this case, install a flywheel diode in parallel with the inductive load (as near as possible to the load.)



If a flywheel diode is connected, the OFF restoration time of the load will become longer. If this becomes a problem, connect a CR snubber circuit to the load, similar to the countermeasure taken for surge voltage in AC output.

### **Precautions for AC** output modules

(1) The AC output module (AC363, AC364) has a built-in fuse of 6A per common. For a load short-circuit, fusing will protect the triacs. However, in this case, semiconductor devices may be damaged to some extent. Therefore, take measures to prevent

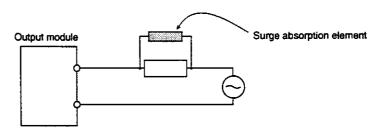
In the case of fusing, or when the external power is not supplied. the LED (FL, FH) on the front of the module will light.

(2) If a capacitive load is connected, rush current will flow when the output is changed to ON. Take necessary measures to suppress this rush current at a value lower than the allowable limit of the module.

Allowable inrush current:

AC363 ... 20 A/20 ms (point), 40 A/20 ms (common) AC364 ... 20 A/20 ms (point and common)

(3) If an inductive load is connected, transient overvoltage will be generated at the output is changed to OFF. To prevent malfunction caused by this surge voltage, a CR snubber circuit is installed in the AC output module. However, to prevent the problem for other signal systems, install a surge absorption element in parallel with the inductive load (install a surge absorption element as near as possible to the inductive load).



Surge absorption element:

Varistor (for the voltage clamp)

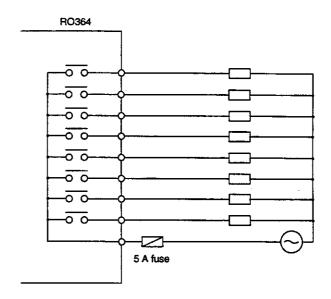
Bi-directional overvoltage absorption element with a rated voltage of approx. 1.2 times of the max. voltage (peak voltage)

Snubber (CR) circuit (for high-frequency attenuation) R  $(\Omega)$ =DC resistance value of the load C ( $\mu$ F)=  $\frac{l^2}{10} \sim \frac{l^2}{20}$  (I : peak value of load current in ordinary time)

(4) Because the AC output module does not have a zero-cross function, the OFF->ON occurs regardless of the load voltage phases. However, the ON->OFF change occurs when load current is near zero. Check this point in load response.

# 3.5 Precautions for relay output modules

- (1) The relay output module (RO364, RO363S) needs external 24 Vdc power for driving relays. (For details, see 2.3, I/O module specifications.) If external 24 Vdc power is not supplied, the LED (F) in the front of the module will light.
- (2) Because the relay output module does not have an built-in fuse to protect from overcurrent, install a fuse appropriate to the load current on the external wire. If the protective fuse is not inserted, module patterns could be burn out when a load is shorted.



(3) The relay output module does not have a built-in surge absorption element. To connect an inductive load, always install a surge absorption element in parallel with the load. For details on selecting a surge absorption element, see 3.3 (5) and 3.4 (3).

# 4.1 Operating environment

Do not install the T3 in the following locations:

- Where the ambient temperature drops below 0°C (32°F) or exceeds 55°C (131°F)
- Where the relative humidity drops below 20% or exceeds 90%
- Where there is condensation due to sudden temperature changes
- Where there are vibrations that exceed the tolerance of the T3
- Where there are shocks that exceed the tolerance of the T3
- Where there are corrosive or inflammable gases
   (The installation location should be below 0.05 ppm of sulfurous acid gas, below 0.01 ppm of hydrogen sulfide.)
- Where there are dust, machining debris or other particles
- In locations exposed to direct sunlight

Observe the following precautions when installing enclosures for mounting the T3:

- Provide the maximum possible distance between highvoltage or high-power panels. This distance must be at least 200 mm (8 in).
- If the enclosures are installed near high-frequency equipment, be sure to ground the enclosures correctly.
- When sharing the channel base with other panels, check for leakage currents from the other panels or equipment.

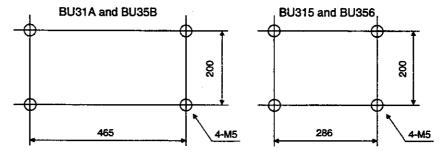
### 4. Installation and Wiring

#### 4.2 Installing units

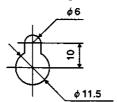
Installation precautions:

- Because the T3 is not dust-proof, install it in a dust-proof enclosure.
- Do not install the unit directly above equipment that generates a large amount of heat, such as a heater, transformer, or largecapacity resistor.
- Do not install the unit within 200 mm (8 in) of a high-voltage or power cable.
- Allow at least 100 mm distance (4 in) on all sides of the unit for ventilation.
- For safety during operation and maintenance, install the unit as far as is possible from high-voltage or power equipment. Alternatively, isolate the unit using a steel plate or similar separator.
- If the unit is installed on a horizontal panel, ambient temperature should be less than 40° C.
- Decide the units mounting position with considering the length of the expansion cables.
- Install the units in fully contacting with the mounting frame in order to equalize the potentials of basic and expansion units.

The unit mounting dimensions are as follows:



Rack mounting hole

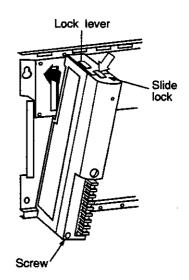


[units:mm]

#### 4.3 Mounting modules

The power supply module must be mounted in the slot at the extreme left of the rack. Install the expansion interface module in the slot next to the power supply module, and the CPU module (for the basic unit only) and I/O modules in the following slots: The modules, except for the expansion interface module, must be installed as follows:

- 1. Slide back the slide lock on the top of the module to release the lock lever.
- 2. Hang the bottom of the module on the rail of the rack and push up the lock lever.
- 3. While setting the bottom of the module as the supporting point, install the module in the slot to match the connector.
- 4. Release the lock lever and lock the module in the rack. Pull the slide lock towards you and lock the lever.





- While operating, fix the module with a screw at the bottom of the module.
- Remove the module in the reverse procedure for installation.
- Connector covers are attached to the rack and module connectors. Remove the connector covers when a module is installed.

Mount an expansion interface module by using a screw in the slot next to the power supply module slot as follows:

- 1. Insert the expansion interface module into the connector next to the power supply module.
- 2. Tighten screws on top and bottom of the module.



CAUTION For safety, turn off power to the T3 before installing or removing a module. Also, refer to Section 6.8 I/O module replacement during operation.

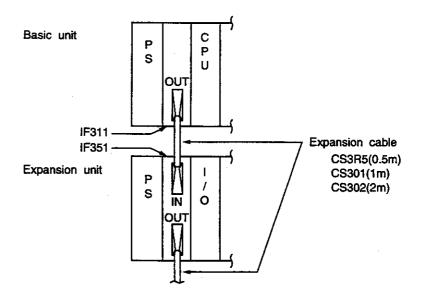
### 4. Installation and Wiring

#### 4.4 Connecting expansion units

Up to three expansion units can be connected to the T3 basic unit. Either the standard type or the long-distance type of expansion configuration can be selected. For details, see 1.2 Unit configuration.

#### Standard expansion

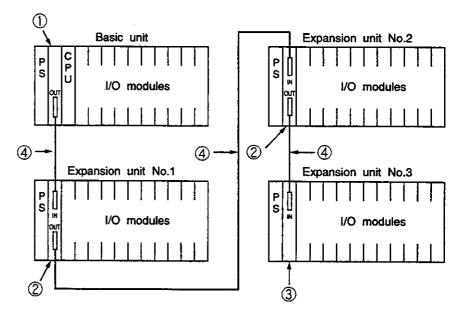
This type of expansion configuration uses the standard type expansion interface modules (IF311 for basic unit, and IF351 for expansion unit).



- The length of the expansion cable between the units is up to 2 meters, and 6 meters in total length.
- The expansion cable connects IN and OUT. Correctly connect IN and OUT.
- Keep the expansion cable away at least 50 mm (2 inch) from the I/O signal cables.
- For details on whether a power supply module for an expansion unit is necessary, see 1.9 Examining the power supply capacity. Change the power supply mode plug of the IF351, depending on the power supply being used. For details, see 1.6 Expansion interface module.

# Long-distance expansion

The following figure outlines the long-distance expansion configuration using the long-distance type expansion interface modules (IF312 for basic unit, IF352 for middle expansion unit and IF353 for end expansion unit).



- ①Long-distance type expansion interface module IF312 (for basic unit)
- ②Long-distance type expansion interface module IF352 (for middle expansion unit)
- ③Long-distance type expansion interface module IF353 (for end expansion unit)
- **Expansion cable (for long-distance expansion)**

CL3R5 (0.5m)

CL301 (1m)

CL305 (5m)

CL310 (10m)

CL320 (20m)

CL340 (40m)

- Maximum total length of the expansion cables is 40m.
- Connect IN and OUT of the expansion cable. To prevent mis-connection, a colored mark is attached on each connector of the expansion cable and the module.
- The expansion cable must be separated as far as possible from power cables and I/O wires.
- Use the IF353 on the end expansion unit for termination.

## 4. Installation and Wiring

#### 4.5 Grounding

To maintain the safety and stable operation of the T3, grounding is very important. Read and follow the check points below before grounding.

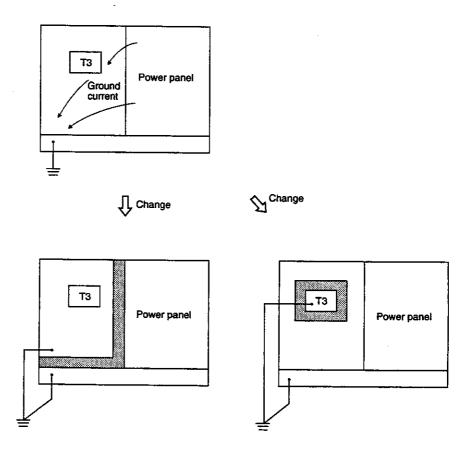
#### Check points for grounding

Check the grounding against the following criteria:

- (1) The T3 must not become a path for ground current. Highfrequency current is particularly harmful.
- (2) Equalize the ground potentials of the basic and the expansion units. Ground them at a single point.
- (3) Do not connect the ground of the T3 to that of high-power systems.
- (4) Do not use a ground that has an unstable impedance, such as painted screws, or grounds subject to vibration.

#### **Grounding of** control panel

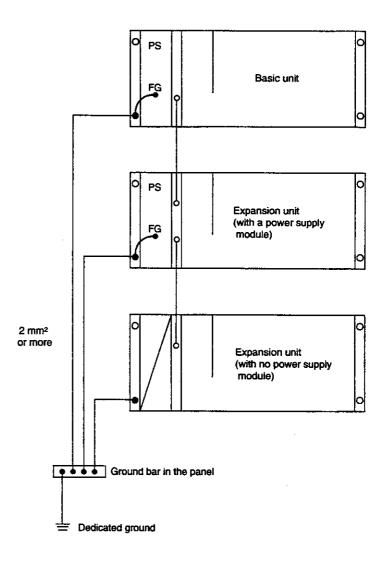
In some cases, the T3 unit becomes a path of ground current from a power panel or high-frequency equipments.



Isolate the T3 mounting panel and connect to the ground point separately.

Isolate the T3 from the mounting frame and connect to the ground point separately.

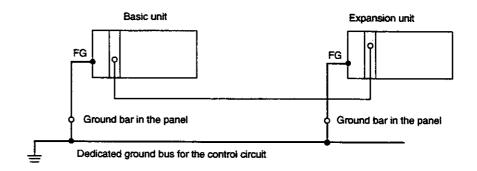
#### **Ground connection** between units



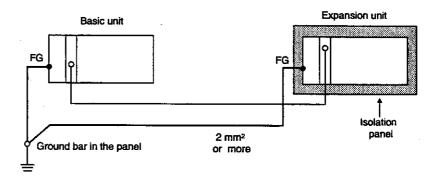
- Connect the FG terminal of the power supply module to the unit mounting screw, and to the ground bar in the panel by 2 mm<sup>2</sup> or larger wire in shortest possible distance.
- Use a dedicated ground for the control circuit, and keep the ground cable away from that for high-power systems.
- $100\Omega$  or less to earth is recommended.

## 4. Installation and Wiring

#### Grounding of longdistance expansion



In principle, ground a long-distance expansion unit as shown in the above figure. If the potential changes at the grounding point, causing malfunctions of the T3, isolate the expansion unit from the mounting frame, and ground it with a dedicated cable (2 mm<sup>2</sup> or more).



# Line filter ground (LG) terminal

The LG terminal is a neutral point of the primary power supply line filter. It can suppress the effect caused by the noise from the power supply line, by grounding the LG terminal.

Therefore, normally, ground the LG terminal together with the FG terminal.

However, depending on the power system, leakage current to the ground from the LG may cause problems. In this case, install an isolated transformer in the power line, or open the LG terminal. If the unit is installed in isolation, open the LG terminal.

Do not connect the LG and FG terminals without grounding them.

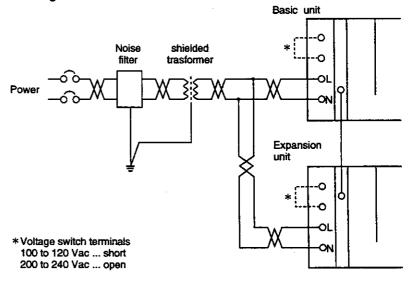
## 4.6 Wiring of the power supply

Wire the external power supply to the T3 power supply module. When using the expansion unit, supply the power simultaneously to the basic and expansion units.

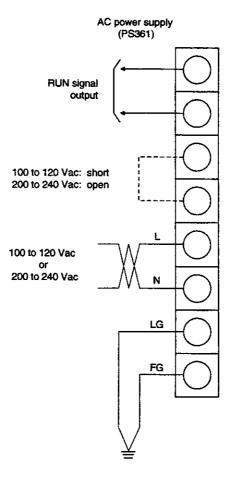
#### (1) Power conditions

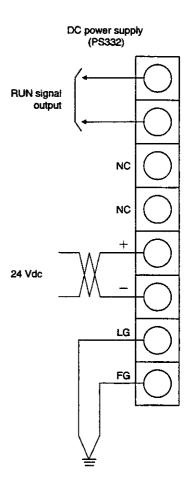
85 to 132 Vac/170 to 264 Vac, 50/60 Hz (PS361)
20.4 to 28.8 Vdc (PS332)
80 VA or less (PS361)
50W or less (PS332)
10 ms or less

- (2) Correctly set the voltage switch terminals of the PS361 according to the power voltage. (100 to 120 Vac: short, 200 to 240 Vac: open)
- (3) Install an electrostatic shielded transformer or a noise filter if the power contains noise. See the figure at the bottom.
- (4) Use twisted-pair cables (1.25 mm<sup>2</sup>) as the power supply cable. Keep the cable as far as possible from the I/O cables.
- (5) If the expansion unit with a power supply module is used, the power for the basic and expansion units should be supplied from the same source. Apply power at the same time or in the order of the expansion unit then the basic unit.
- (6) If a CVCF or UPS supplies power to the T3, observe waveforms of the power supply; the peak voltage must be more than 130V for the 100 to 120 Vac setting or 260V for the 200 to 240 Vac setting.



#### Wiring of the power supply module





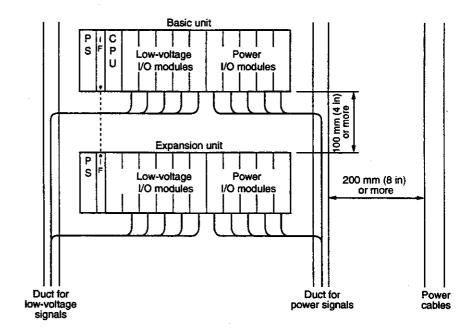


- CAUTION (1) The size of the terminal screw is M3.5. Use an appropriate crimp-style terminal with a width of 7 mm (0.27 in) or less for the M3.5 screw.
  - (2) The terminal block can be removed. Turn OFF the power before removing the terminal block for safety.
  - (3) The recommended cable size for the power supply module is 1.25 mm<sup>2</sup>.

4.7

I/O wiring

The following module layout is recommended for noise immunity.



I/O modules for
low-voltage system
DC input module
Analog input module
Analog output module
Pulse input module
ASCII module
Data link module

I/O modules for
power system
AC input module
DC output module
AC output module
Relay output module

- (1) To improve the unit's resistance to signal interference, install modules for low-voltage signals toward the left of the unit, and modules for power signals toward the right. Also, separate the wires of each.
- (2) Allow at least 100 mm (4 in) clearance between the units and between other control equipment to allow access for maintenance and ventilation.
- (3) When installing the unit near high-voltage or high-power equipment, leave at least 200 mm (8 in) clearance, or shield the unit with a steel plate.

## 4. Installation and Wiring

(4) Refer to the following table for the size of I/O cables.

Type of module	Cable size
16-point module	0.75~1.25 mm <sup>2</sup>
32-point module	0.5∼0.75 mm²
64-point module	0.1~0.3 mm <sup>2</sup>

Use a larger size cable for the common line. For the field-wiring cable, 1.25 mm<sup>2</sup> or larger cable is recommended.

- (5) The M3.5 screw is used as a terminal screw. Use an appropriate crimp-type terminal with a width of 7 mm (0.28 in) or less for the M3.5 screw.
- (6) Do not bind the I/O signal cables and high-voltage or power cables. Separate them as far as possible. If separation is difficult, use shielded cables for the I/O signals and ground the shield at the leading-in point of the control panel.

## 5.1 Daily checking items

To maintain the system and to prevent troubles, check the following points on daily basis.

ltem	Content of checking	Corrective measures
LEDs on the power supply and	POWER (green): Lit when 5V power normal	If the LEDs are abnormal, see Section 6, Troubleshooting.
CPU modules	RUN (green): Lit when operating normally	o, moubleshooding.
	FAULT (red): Not lit when the CPU normal.	
	I/O (red): Not lit when the I/O modules normal.	
	BATT (green): Lit when the battery voltage normal.	
Input LEDs (digital input)	Lit when the corresponding input signal is ON.	Check that the input voltage is within the specified range. Check that the input terminal block is not loose. Check that th modules are installed securely.
Output LEDs (digital output)	Lit when the output is ON and the corresponding external load should operate. Also, check that the LEDs (FL, FH, or F), which indicate a blown fuse and/or abnormal external power, are not lit.	●Check that the external load voltage is within the specified range. ● Check the built-in fuses. ●Check that the output terminal block is not loose. ●Check that the modules are installed securely.
Switches on the CPU module	Check that the operation mode switch (HALT/RUN/P-RUN) and the RAM/ROM switch are at the correct position.  Operations are executed when the mode switch is set to RUN or P-RUN.	Change the switch to the correct position.



CAUTION If a serious error (e.g., the system RAM abnormal) is detected when the power is turned ON, the FAULT and I/O LEDs will blink. In this state, communication with the programmer is not possible. If that error continues even if the power is again turned ON, replace the CPU module.

## 5.2 Periodical checking items

Check the T3 based on the following points every six months. Also perform checks when the operating environment is changed.

Item	Content of checking	Corrective measures
Power supply	Measure the voltage of the power (at the terminal of the module)	85 to 132/170 to 264 Vac 20.4 to 28.8 Vdc
	Check that the terminal screw of the module is not loose.	Check that the terminal screw of the module is not loose.
	Check that wiring cable is not damaged.	Check that wiring cable is not damaged.
Installation condition	Check that the basic unit is installed securely.	Not loose, no play
00110111011	Check that the expansion unit is installed securely.	Not loose, no play
	Check that each module is installed securely.	Not loose, no play
	Check that each expansion cable connector is not loose; and the cable is not damaged.	Not loose, not damaged
Programmer	Check that the functions of the programmer are normal.	Try executing simple operations.
	Check that the connector and the cable are not damaged.	Not damaged
I/O modules	Measure the voltage of each of the I/O modules at the terminal block.	The voltage must be within the specified range.
	Check the LED of the input status display.	The LED must light normally.
	Check the LED of the output status display.	The LED must light normally.
	Check that the I/O terminal block is installed securely.	Not loose, no play
	Check that the terminal screw is not loose and the terminal has a sufficient distance to the next terminal.	Not loose, and not contacting the next terminal
	Check that the wiring cable is not damaged.	Not damaged
Environment	Check that the temperature, humidity, vibration, dust, etc. are within the specified range.	Must be within the general specification range.
Program .	Check that the content of the PLC program and the master program (e.g., saved on a floppy disk) are the same.	Check that these programs are identical by comparison.
Battery	Check whether the battery must be replaced. (The installed date is written on the rear of the CPU battery cover.)	Replace the current bettery if more than two years has elapsed.
	Check that the connector of the battery is inserted firmly.	Not loose

## 5.3 Maintenance parts

To recover from failure quickly, it is recommended to keep the following spare parts:

Part	Quantity	Remarks	
I/O moduie	One of each type used	Check the service life of the relay output. See Section 2.3.	
Fuse	Number to be used	See Section 5.5.	
Battery	1	For emergency. See Section 5.4.	
CPU module	1	Prepare at least one each to minimize	
Power supply module	1	the down-time of the system.	
Programmer	1	Useful for the troubleshooting procedure.	
Master program	As required	Saved in a disk, or other media.	

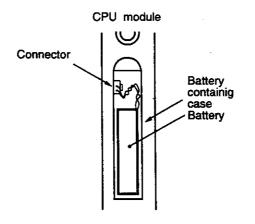
Do not store spare parts in high temperature and humidity locations.

Keep the temperature at ordinary room temperature or below because the battery discharges when the ambient temperature is high.

## 5.4 Replacing battery

The lithium battery is used for maintaining the T3's RAM memory during power OFF. The battery is installed at factory shipment. The installed date of the battery is marked on the rear of the battery cover of the CPU module. Under normal service conditions, it is recommended to replace the battery every two years. Check the installed date and replace the battery with a new one if two years have elapsed.

The LED (BATT), which indicates the battery voltage is normal, is installed in the front of the CPU module. The LED lights when the battery voltage is normal. If this LED does not light or blinks, the service life of the battery has ended. Replace the battery within 14 days. To maintain the RAM program, it is recommended to keep the power ON until the battery is replaced.



- ① Remove the battery cover.
- ② Remove the battery from its case.
- 3 Unplug the connector of the battery.
- ④ Connect a new battery connector.
- ⑤ Insert a new battery into its case.
- 6 Mount the battery cover on its case.

## 5. Maintenance and Checking



- **CAUTION** 1. The battery can be replaced either with power ON or with power OFF.
  - However if the battery is replaced with power OFF, insert a new battery within five minutes after the old battery is removed. If the new battery is not inserted quickly, the data in RAM memory will be lost.
  - 2. Keep the following points in mind when handling batteries.
    - Do not replace a lithium battery with a manganese dry cell or an alkaline battery since their voltages are not compatible with the former.
    - Do not short the + (positive) and the (negative) terminals of the battery.
    - Do not dismantle, or apply heat to, or throw the battery into fire.
    - Do not try to charge a battery. This is dangerous.
  - 3. The battery is dedicated for Toshiba PLC. Order it from Toshiba. (Part code: TBT911\*AS)

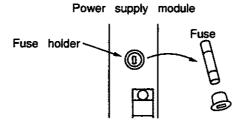
5.5 Replacing fuses

The following modules have built-in protection fuses.

Name of module (type)	Fuse type	Number of units	Fuse rating
AC power supply (PS361)	FU913	1	250 Vac - 3A
DC power supply (PS332)	FU916	1	250 Vac - 6A
DC output (DO333)	FU916	2	250 Vac - 6A
DC output (DO334)	FU916	2	250 Vac - 6A
AC output (AC363)	FU916	2	250 Vac - 6A
AC output (AC364)	FU916	2	250 Vac - 6A

The AC and DC power supply modules have a built-in protective fuse to prevent burn-out of internal circuits of the modules. Over long term use, ON/OFF changes of the power may cause fatigue; check the fuse periodically (a spare fuse is attached). The above output modules have protective fuses to prevent their internal circuits from burn-out when short-circuit occur. In the front of each output module, the LEDs (FL, FH or F) which indicate the status of fuses are provided. When a fuse is blown, these LEDs light.

Replacing the fuse of the power supply module



- ① Remove the fuse holder from the front of the module.
- ② Remove the blown fuse. ③ Install a new fuse.
- 4 Attach the fuse holder.

## 5. Maintenance and Checking

### 5.6 IC memory card handling

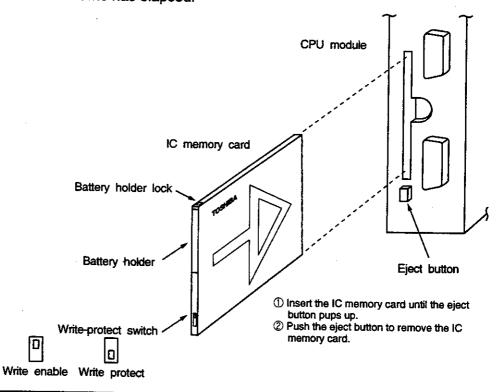
By inserting the IC memory card (type: ME914) into the CPU module, program loading/saving between the IC memory card and T3's memory or use of expanded file registers become available. (For details, refer to the "T3 User's Manual - Functions" in a separate volume.) By inserting the IC memory card which stores a user program, the program can be transferred to the RAM of the CPU without using the programmer. Use the following procedure:

- ① Turn OFF power. Insert the IC memory card into the CPU module.
- ② Set the RAM/ROM switch of the CPU module to ROM, and set the operation mode switch to HALT.
- ③ Turn ON power.

The above procedure enables the program stored in the IC memory card to transfer the RAM memory of the T3.

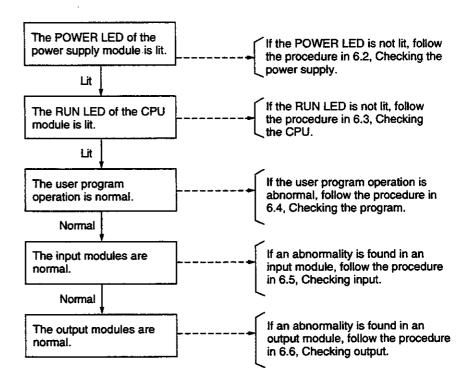
Note the following points when handling the IC memory card.

- (1) The IC memory card can be inserted or ejected while power ON.
- (2) To maintain the memory, the IC memory card has a built-in battery (coin type lithium battery CR2325, approx. one year of service life at 20°C).
  If power is applied to the IC memory card for more than ten minutes before removing the card, it can maintain the memory for approx. 30 minutes after the lithium battery is removed. However, memory on the IC memory card disappears if a longer time has elapsed.



**Troubleshooting** procedure

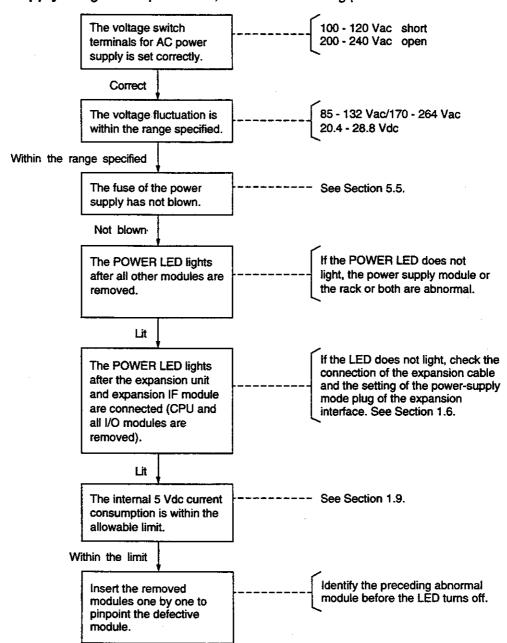
If a trouble occurs, determine whether the cause lies on the mechanical side or on the control system (PLC) side. A problem may cause a secondary problem, therefore, try to determine the cause of the trouble by considering the whole system. If the problem is found in the T3 or in the T3's I/O operation, check the following points:



If the problem appears temporary and is synchronous with the operation of the system/equipment, the external environment (noise, voltage fluctuations, etc.) may have caused it. For details, follow Section 6.7.

6.2 Checking the power supply

If the POWER LED in the front of the power supply module does not light after power ON, check the following points:

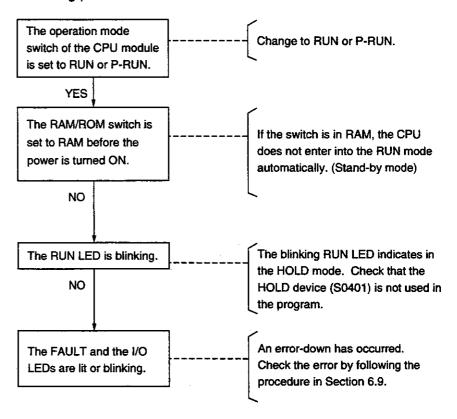




- (1) Turn OFF power before disconnecting cables and removing modules.
- (2) The blown fuse of the power supply may be caused by a failure of an internal circuit.

6.3 Checking the CPU

If the POWER LED is lit, but the RUN LED is not lit, check the following points:



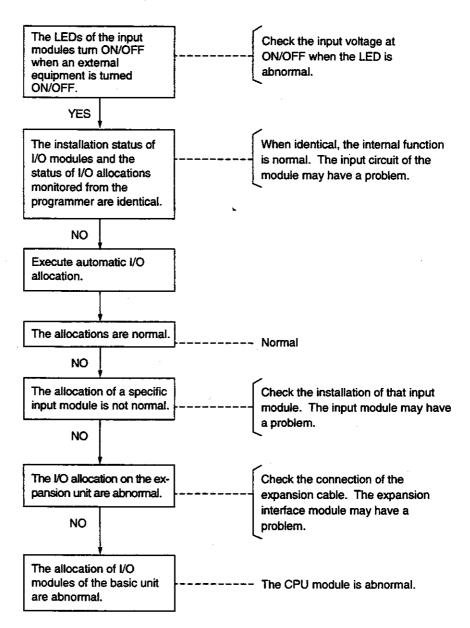
## 6.4 Checking program

Check the program based on the following points if it is running but the operation does not work as intended.

- (1) Output is not carried on the same coil or register of two or more locations during one scanning; the devices for coil instructions and for function instructions are not overlapping.
- (2) The signal which changes faster than the scanning cycle is not input.
- (3) Timer register or counter register is not duplicated.
- (4) When an interrupt is used, the device/register which is used in the main program is not operated erroneously in the interrupt routine.

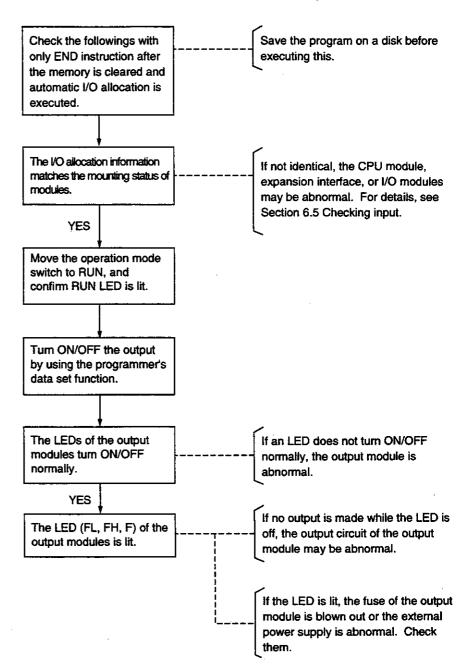
6.5 Checking input

If the program is running, but the input signal is not read normally, check the following points:



6.6 **Checking output** 

If the output to registers and devices is normal, but the actual output to equipment is abnormal, check the following points:



## 6. Troubleshooting

### 6.7 Troubles due to external factors

If one of the following abnormalities occurs in the system, check possible external factors.

- (1) If an abnormality occurs synchronously with the operation of I/O equipment: The noise caused at ON/OFF of the output equipment may be the source of the abnormality. Take necessary measures mentioned in Section 3 Precautions for I/O modules.
- (2) If an abnormality occurs synchronously with the operation of surrounding equipment or high-frequency equipment: The noise induced on I/O signal lines may be the source of the abnormality. The surge voltage, voltage fluctuations, or differences of grounding potentials may have caused the abnormality, depending on the power supply system or the grounding system. Check the abnormality in accordance with the precautions in Section 4 Installation and Wiring. For some cases, isolation from the ground may lead to the stable operation.
- (3) If an abnormality occurs synchronously with the operation of machinery: The vibration of the equipment may have caused the abnormality. Check that the installation status of the units and modules and take necessary measures, including the use of vibration-proof installation.
- (4) If a similar failure is repeated after the module is replaced: Check that no metal debris or water drops have been entered into the unit/module. Apart from the above points, consider environmental conditions. If the ambient temperature is beyond the specified range, stable operation of the system is not guaranteed.

## 6.8 I/O module replacement during operation

If an I/O module becomes abnormal during operation, the module can be replaced with a new one during the system operation. The procedure is as follows:

- ① Connect the programmer to the CPU module.
- 2 From the programmer, specify the module for removal. (The module is disconnected from the T3 operation.)
- ③ Remove the failed module.
- 4 Insert a new module.
- ⑤ By using the programmer, cancel the function for removal.

This function can be applied to the following failures of discrete I/O modules.

- An input module does not read the specific signal (failure of the input photo-coupler, etc.).
- An output module does not output a specific signal (failure of the output device, etc.).
- The fuse of an output module has blown out.



- **CAUTION** (1) Except when using this function, turn OFF power before replacing a module. Exercise caution when this function is used for safety.
  - (2) Effective I/O modules for this function are the discrete I/O modules. (See separate T3 User's Manual-Fanctions, for
  - (3) Refer to 4.3 Mounting modules, for replacing I/O modules.

### 6.9 List of self-diagnostic items

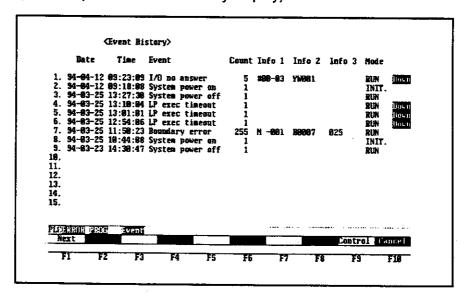
If an error is found through the self-diagnostic check of the CPU of the T3, error messages (and related information) shown in the tables on the following pages will be recorded in the T3's event history table. If the error is so severe and continuation of operation is not possible, the T3 turns OFF all outputs and stops the operation (error-down).

The latest 30 error messages and the time and date of the errors are stored in the event history table. Those error messages can be displayed on the programmer. (Power ON/OFF is also registered.)

If the T3 has entered to error-down, connect the programmer to the T3 to confirm the error message in the event history table. The procedure to display the event history is as follows:

- ① Connect the CPU module of the T3 and the programmer (T-PDS) via dedicated cable.
- ② Turn ON the power of the programmer (T-PDS). The power of the T3 must be turned ON in advance.
- ③ Type "TPDS □" from the programmer (T-PDS) to start the T-PDS.
- 4 Press any key to display the main menu of the T-PDS. At this time, check that "Receive timeout" is not displayed on the screen.
- ⑤ In this state, type the S and E keys to display the event history.

(An example of the event history display)



When "Receive timeout" is displayed on the screen, communications between the programmer (T-PDS) and T3 are not established. Blinking FAULT or I/O LEDs indicates a failure of the CPU. If this state continues even after the power turned ON again, replace the CPU module with a new one. If "Receive timeout" is displayed on the screen while FAULT or I/O is ON and not blinking. check the setting environment of the programmer (T-PDS) and the connection cable. If these are correct, the communication circuit of the CPU module or programmer may have become abnormal.

When the event history is displayed, check the error messages registered. Error message No.1 indicates the latest event registered.

The following pages of this manual explain, error messages and related information, relevant special relays, the status of LEDs after event occurrences, and their meanings. If an error occurs, identify the cause of the error based on the error message on the screen and take necessary measures.

In the error-down state, operations to correct the program are not accepted. In this case, execute Error reset from the programmer to return to the HALT mode before starting the correction operation. To activate RUN again, turn the operation mode switch to HALT and change to RUN (or P-RUN), or execute an operation command from the programmer.



**CAUTION** If the CPU module has an EEPROM or an IC memory card, the program of the EEPROM or the IC memory card will be transferred to RAM when the RAM/ROM switch is set to ROM and RUN is activated (except when the operation mode switch is set to P-RUN); in this case, the corrections on RAM memory will be lost. Therefore, to check the operation of a program corrected in the RUN mode, turn the RAM/ROM switch to RAM before activating RUN.

The meanings of LED displays shown in the tables on the following pages and onward are as follows:

: Lit

O: Not Lit

: Blinking

-: No effect on state

Mosning of the prior and	countermeasures	Power ON (no error)	Power OFF (no error)	The 5-volt power of the expansion unit, or the termination of the expansion IF module is not normal. Check whether power supply to the expansion unit is overload; the power supply of the basic unit is ON but the power supply of the expansion unit is OFF; and the expansion IF module is terminated correctly.	A power interruption is detected. When the power interruption detecting function is used, the operation is stopped if a power interruption longer than the specified time is detected.	The power interruption has been recovered. When the hot restart function is used, the operation is restarted without initialization.	An abnormality has been found in executing read/write check on the user data memory (RAM). If the abnormality continues after the power supply is turned ON again, replace the CPU module.	BCC check of the user program memory (RAM) has detected an abnormality. After "clear memory" is executed, reload the program.	When turning the power ON, the voltage drop of the battery to back up the RAM memory has been detected. (The BATT LED is off. No error-down.) Replace the battery with a new one.
ş	0/1			•	0		0	0	1
LED displays	FAULT			•	•		•	•	ı
	RUN			0	0		0	0	ı
Relevant	special relay			S0024 S0024	S001D	S001C	S0004 S0012	S0030	S000F
	Information 3			·			Test data		
Information	Information Information						Error data		
e and related	Information						Address of the error occurred	BCC error data	
Error message and related information	Error message	System power on	System power off	Expansion unit err	Power interrupt	Power intr resumed	RAM check error	Program BCC error	Batt voltage drop
	Part		supply				Memory		

Meaning of the error and	Q	BCC abnormality has been detected in the user program of the EEPROM (transfer is not executed). Check the program and try writing into the EEPROM again.	The number of times of writing into the EEPROM has exceeded the service life (100,000 times). Because the possibility of an abnormality in writing into the EEPROM will rise, replace the CPU module with a new one.	C Read/write check of the system memory (RAM) has detected an abnormality. If the abnormality continues after turning ON the power again, replace the CPU module.	The BCC check of the system ROM has detected an abnormality. If the abnormality remains after the power is turned ON again, replace the CPU module.	Checking the peripheral control LSI of the CPU module has detected an abnormality. If the abnormality continues after the power is turned ON again, replace the CPU module.	
LED displays	FAULT	•	I	•	•	•	
	RUN	0	I	0	0	0	
Relevant	special	S0004 S0023	20002	S0004 S0011	S0004 S0010	S0004 S0016	
	Information 3			Test data			
Information	Information Information			Error data			
e and related	Information 1	BCC error data	Number of times of writing exceeded	Address of the error occurred	Abnormal BCC data	Error code	
Error message and related information	Error message	EEPROM BCC error	EEPROM warning	Sys RAM check err	Sys ROM BCC error	Peripheral LSI err	
	Part	Метогу		СР			

Error messag	Error message and related information	1 .		Relevant	"	LED displays	s	Meaning of the error and
Error message	Information 1	Information Information	Information 3	relay	RUN	FAULT	2	countermeasures
Clock-calendar err				S000A	1	I		An abnormality has been detected in the data of the built-in calendar LSI (No error-down occurs). If the abnormality remains after the calendar is reset, replace the CPU.
llegal sys intrpt	Interrupted address 1	Interrupted address 2			I	1	I	The CPU module received a request for interrupt not registered (No error-down occurs). If the abnormality occurs frequently, replace the CPU module.
WD timer error	Address 1	Address 2		S0004 S001F	0	•	0	A watchdog timer error has been detected. If the abnormality occurs frequently, replace the CPU module.
I/O bus error	Unit No.	Data		S0005 S0020	0	•	•	An abnormality has been detected in I/O bus checking. Check that the connection of cables and the mounting conditions of the modules are correct.
I/O mismatch	Unit No Slot No.	Register No.		S0005 S0021	0	•	•	The I/O allocation information and the actual I/O module mounting are not identical. Set the I/O allocation information correctly.
/O no answer	Unit No Slot No.	Register No.	-	S0005 S0022	0	•	•	I/O modules are not mounted in the slots where I/O allocation is specified. Mount modules in the slots, or activate the system in the RUN-F mode (forcible operation).
I/O parity error	Slot No P	Register No.		S0005 S0023	0	•	•	A parity error has been detected when transferring data from/to I/O modules. Check the mounting condition of the I/O modules.
	\$							

	Error message and relate	e and related	d information		Beleviant		ED displaye		
Part	Error message	Information 1	Information Information	Information		NO.	FAULT	9	Meaning of the error and countermeasures
0/	Invalid I/O intrpt	Unit No Slot No.			S0005 S0025	1	ı		A request for I/O interrupt from an interrupt module not registered has been detected (No error-down occurs). Register the interrupt module, or do not mount that interrupt module.
	Duplicate I/O reg	Unit No Slot No.	Register No.		S0005 S0021	0	•	•	An overlap is detected in allocating I/O registers to I/O modules. Correct the I/O allocation information.
	Illegal I/O reg	Unit No Slot No.	Register No.		S0005 S0021	0	•	•	The allocation of I/O modules to I/O registers has exceeded the limit. Reduce the number of allocations to I/O modules.
Proc- essing	LP function error	Error code	Error data		S0004 S0015	0	•	0	An abnormality is detected in the language processor (LP). If the abnormality remains after power cycle, replace the CPU module.
	LP reg R/W error	Port No.	Error data	Test data	S0004 S0015	0	•	0	At initial setting of the language processor (LP), an abnormality has occurred in the read/write checking. If the abnormality remains after power cycle, replace the CPU module.
	LP exec timeout				S0004 S0015	0	•	0	The execution of the language processor (LP) did not finish within a time specified. Reduce the program execution time or use the "WDT" instruction. If the situation is repeated after power cycle, replace the CPU module.
	Scan time over	Scan time			\$0006 \$0031	0	•	0	The scan time exceeded 200 ms. Reduce the scan time or use the "WDT" instruction.

_			T				
Meaning of the error and	countermeasures	The "END" instruction has not been found in the main program or in the subprogram, or the "IRET" instruction has not been found in the interrupt program. Write the "END" instruction or the "IRET" instruction at the end of the program.	An abnormality has been found in combination of the MCS/R and JCS/R instructions. Check the combination of MCS/R and JCS/R instructions is correct.	Specifying the operand for the coll instruction or the FUN instruction is abnormal. Check that an input (X) is not allocated to an output operand.	An abnormality is detected in the program management information. Execute "Clear memory" and re-load the program.	The "LBL" instruction for the "JUMP" instruction is not programmed in the same program type. Or, the "LBL" instruction is programmed at an address before the "JUMP" instruction (backward jump). Insert the "LBL" instruction at the right position.	
lys	0/	0	0	0	0	0	
LED displays	FAULT	•	•	•	•	•	
	RUN	0	0	0	0	0	
Relevant	special relay	S0030	S0030	80006 80030	0600S	S0030	
	Information 3					Jump label No.	
information	Information Information 1 Information 3	Address in the block	Address in the block	Address in the block		Address in the block	
Error message and related information	Information 1	Program type - Block No.	Program type - Block No.	Program type - Block No.	Program type - Block No.	Program type - Block No.	
Error messagi	Error message	END/IRET error	Pair inst error	Operand error	Invalid program	Jump target error	•
	Part	Program					

	Error message and related information	and related	nformation		Relevant	37	LED displays	S.	Meaning of the error
Part	Error message	Information 1	Information information Information	Information 3	special relay	RUN	FAULT	0/1	countermeasures
Program	No sub-r entry	Program type - Block No.	Address in the block	Subroutine No.	S0030	0	•	0	The "SUBR" instruction of the subroutine No. specified by the "CALL" instruction is not programmed. Insert the "SUBR" instruction.
	No RET error	Program type - Block No.	Address in the block	Subroutine No.	S0008	0	•	0	The "RET" instruction is not programmed in the subroutine. Insert the "RET" instruction.
	Sub-r nesting err	Program type - Block No.	Address in the block	Subroutine No.	S0006 S0030	0	•	0	The number of nesting of subroutines exceeds six overlays. Change the program to reduce the number of nesting overlays to six or fewer.
	Loop nesting error	Program type - Block No.	Address in the block		S0030	0	•	0	The number of nestings of "FOR" and "NEXT" instructions exceed six overlays. Reduce the number of overlays of the "FOR" and "NEXT" instructions to six or fewer in the program.
	SFC step No. error	Program type - Block No.	Step No.		S0030	0	• .	0	Step No. is duplicated in the SFC program, or the step Nos. specified by the initial step and the end step are not identical. Change the step No., or check the step No. of the end step.
	SFC macro No. err	Program type - Block No.	Macro No.		S0030	0	•	0	Macro No. is duplicated, or the same macro program is called from two or more locations.  Change the macro No. Or, limit the calling of the macro program to one location.

1	Error message	Error message and related information	nformation		Relevant		LED displays	မွှာ	A Society of the section of the sect	
	Error message	Information 1	Information 2	Information 3		RUN	FAULT	2	countermeasures	
Program	No SFC macro entry	Program type - block No.	Macro No.		\$0006 \$0030	0	•	0	The macro program specified by macro step is not programmed. Check that the macro program has been programmed, and that the macro No. is correct.	
07	SFC jump label err	Program type - block No.	SFC label No.		S0006 S0030	0	•	0	The SFC label No. is duplicated. Change the SFC label No.	
	No SFC jump label	Program type - block No.	SFC tabel No.		S0006 S0030	0	•	0	The SFC label instruction specified by the SFC jump instruction is not programmed. Insert the SFC label instruction.	
	Duplicate SFC No.	Program type - block No.	SFC program No.		S0006 S0030	0	•	0	The SFC program No. is duplicated. Change the SFC program No.	
	Invalid SFC prog	Program type - block No.			9000S	0	•	0	The correspondences between the initial step and end step or SFC end, or macro entry and macro end do not match. Change the program so that the correspondences match.	
	llegal inst	Program type - block No.	Address in the block		S0006 S0030	0	•	Ö	An illegal instruction has been detected in the program. After executing "Clear memory," reload the program.	
=	Invalid Fun inst	Program type - block No.	Address in the block	FUN No.	S0006 S0030	0	•	0	An instruction which is not supported by T3 has been detected. Erase the relevant instruction.	
ш .	Boundary error	Program type - block No.	Address In the block	FUN No.	S0064 or S0065	ı	ı	l	The operand specified by indexed FUN instruction has exceeded the limit. Check the value of the index register.	
	Duplicate entry No.	Program type - block No.	Address in the block	Entry No.	S0006 S0030	0	•	0	"LBL" or "SUBR" instruction is duplicated. Check the program.	

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Meaning of the error and	countermeasures	BCC error has been detected in the user program stored in the IC memory card (transfer Is not executed).	When the initial load is executed from the IC memory card at power up, loading cannot take place because the program capacity in the IC memory card is greater than the RAM capacity of the T3	
sk	0/1	0	0	
LED displays	FAULT	•	•	
	RUN	0	0	
Relevant	special relay	S0004 S0014	S0004	
	Information 3			
nformation	Information 2			
and related i	Information 1			
Error message and related information	Error message	IC card BCC error	IC card type error	
	Part	IC memory card		

# **TOSHIBA**

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